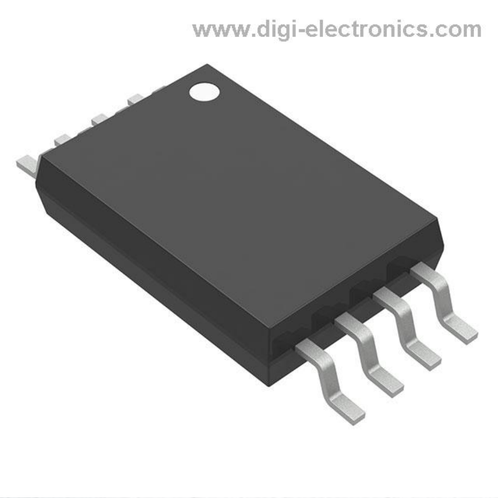
TLV2422CPWR Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number	TLV2422CPWR-DG
Manufacturer	Texas Instruments
Manufacturer Product Number	TLV2422CPWR
Description	IC OPAMP GP 2 CIRCUIT 8TSSOP
Detailed Description	General Purpose Amplifier 2 Circuit Rail-to-Rail 8-TSSOP

Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
TLV2422CPWR	Texas Instruments
Series:	Product Status:
LinCMOS™	Obsolete
Amplifier Type:	Number of Circuits:
General Purpose	2
Output Type:	Slew Rate:
Rail-to-Rail	0.02V/µs
Gain Bandwidth Product:	Current - Input Bias:
5.3 MHz	1 pA
Voltage - Input Offset:	Current - Supply:
300 µV	100µA (x2 Channels)
Current - Output / Channel:	Voltage - Supply Span (Min):
50 mA	2.7 V
Voltage - Supply Span (Max):	Operating Temperature:
10 V	0°C ~ 70°C
Mounting Type:	Package / Case:
Surface Mount	8-TSSOP (0.173", 4.40mm Width)
Supplier Device Package:	Base Product Number:
8-TSSOP	TLV2422

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.33.0001	

TLV2422, TLV2422A, TLV2422Y Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT WIDE-INPUT-VOLTAGE MICROPOWER DUAL OPERATIONAL AMPLIFIERS

SLOS199C – SEPTEMBER 1997 – REVISED APRIL 2001

- **Output Swing Includes Both Supply Rails**
- **Extended Common-Mode Input Voltage Range . . . 0 V to 4.5 V (Min) With 5-V Single Supply**
- **No Phase Inversion**
- **Low Noise . . . 18 nV/√Hz Typ at f = 1 kHz**
- **Low Input Offset Voltage 950 μV Max at T_A = 25°C (TLV2422A)**
- **Low Input Bias Current . . . 1 pA Typ**
- **Micropower Operation . . . 50 μA Per Channel**
- **600-Ω Output Drive**
- **Available in Q-Temp Automotive HighRel Automotive Applications Configuration Control / Print Support Qualification to Automotive Standards**

description

The TLV2422 and TLV2422A are dual low-voltage operational amplifiers from Texas Instruments. The common-mode input voltage range for this device has been extended over the typical CMOS amplifiers making them suitable for a wide range of applications. In addition, the devices do not phase invert when the common-mode input is driven to the supply rails. This satisfies most design requirements without paying a premium for rail-to-rail input performance. They also exhibit rail-to-rail output performance for increased dynamic range in single- or split-supply applications. This family is fully characterized at 3-V and 5-V supplies and is optimized for low-voltage operation. The TLV2422 only requires 50 μA of supply current per channel, making it ideal for battery-powered applications. The TLV2422 also has increased output drive over previous rail-to-rail operational amplifiers and can drive 600-Ω loads for telecom applications.

Other members in the TLV2422 family are the high-power, TLV2442, and low-power, TLV2432, versions.

HIGH-LEVEL OUTPUT VOLTAGE vs HIGH-LEVEL OUTPUT CURRENT

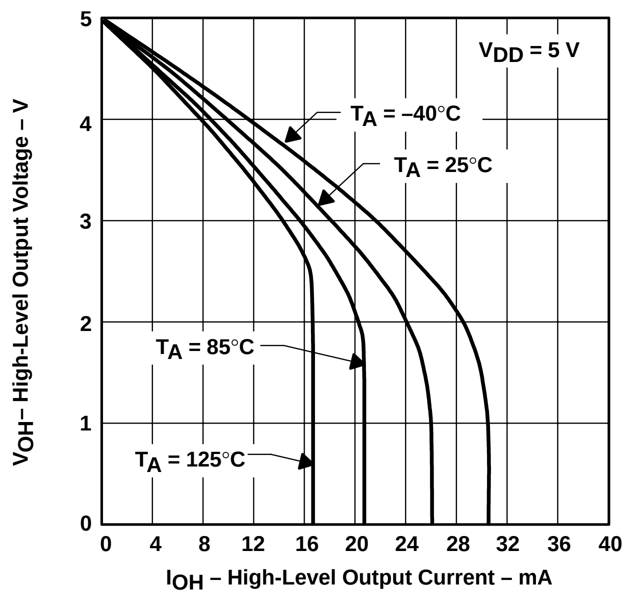


Figure 1

The TLV2422, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels and low-voltage operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single- or split-supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs). For precision applications, the TLV2422A is available with a maximum input offset voltage of 950 μV.

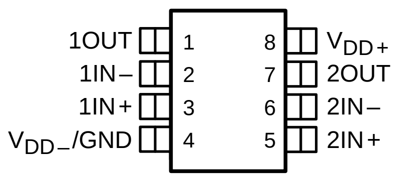
If the design requires single operational amplifiers, see the TI TLV2211/21/31. This is a family of rail-to-rail output operational amplifiers in the SOT-23 package. Their small size and low power consumption, make them ideal for high density, battery-powered equipment.

AVAILABLE OPTIONS

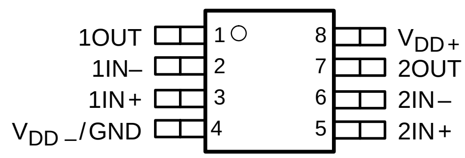
T_A	V_{IO}max AT 25°C	PACKAGED DEVICES					CHIP FORM (Y)
		SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (JG)	TSSOP (PW)	CERAMIC FLAT PACK (U)	
0°C to 70°C	2.5 mV	TLV2422CD	—	—	TLV2422CPWLE	—	TLV2422Y
–40°C to 85°C	950 µV 2.5 mV	TLV2422AID TLV2422ID	— —	— —	TLV2422AIPWLE —	— —	
–40°C to 125°C	950 µV 2.5 mV	TLV2422AQD TLV2422QD	— —	— —	— —	— —	
–55°C to 125°C	950 µV 2 mV	— —	TLV2422AMFK TLV2422MFK	TLV2422AMJG TLV2422MJG	— —	TLV2422AMU TLV2422MU	

The D packages are available taped and reeled. Add R suffix to device type (e.g., TLV2422CDR). The PW package is available only left-end taped and reeled. Chips are tested at 25°C.

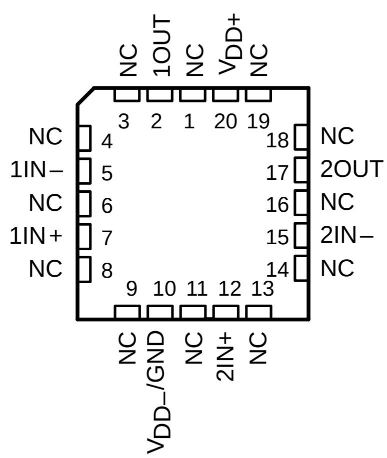
D OR JG PACKAGE
(TOP VIEW)



PW PACKAGE
(TOP VIEW)

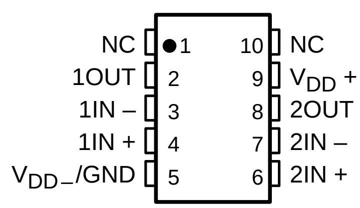


FK PACKAGE
(TOP VIEW)

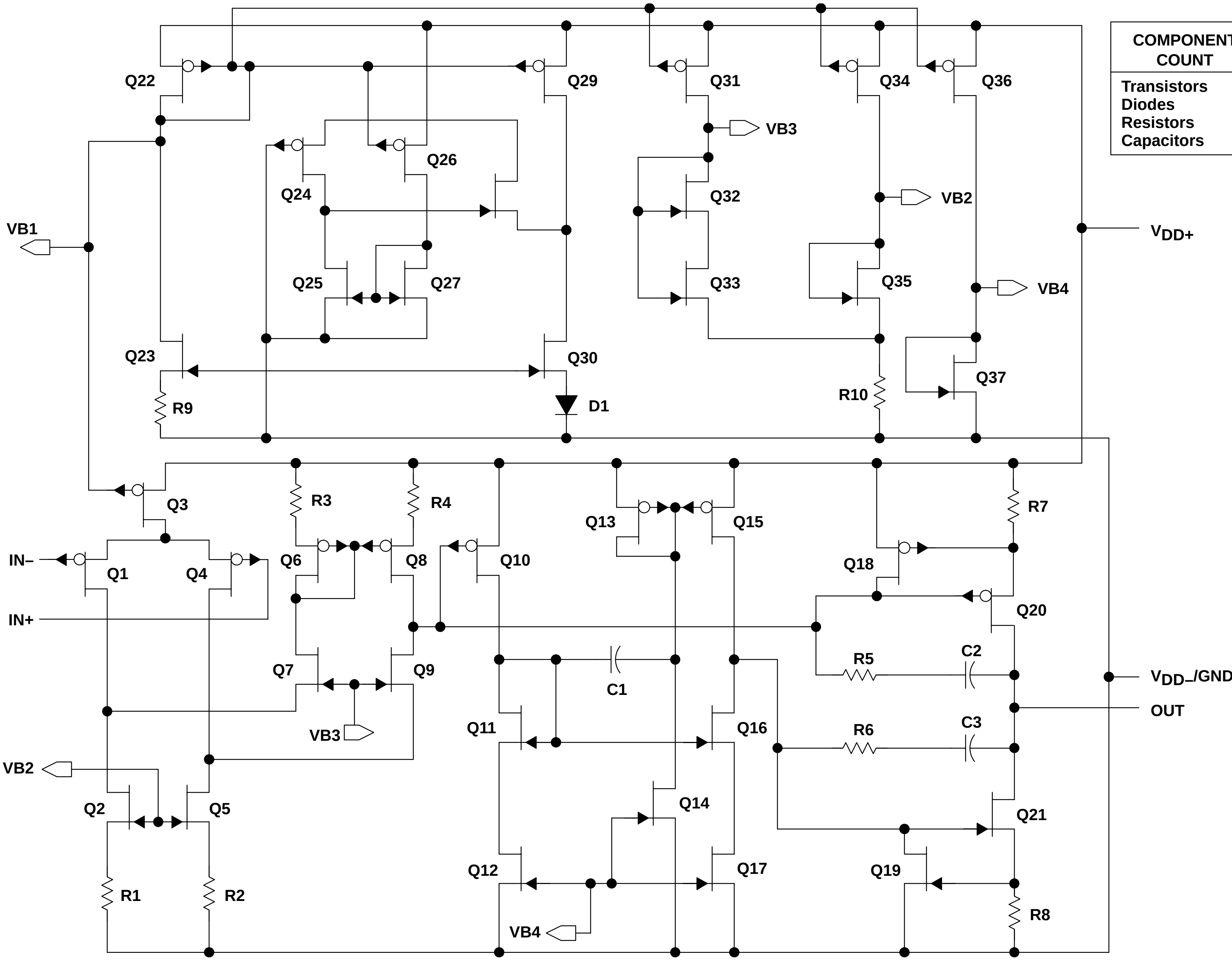


NC – No internal connection

U PACKAGE
(TOP VIEW)



equivalent schematic (each amplifier)



COMPONENT COUNT	
Transistors	69
Diodes	5
Resistors	26
Capacitors	6

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{DD} (see Note 1) . . . . . 12 V
Differential input voltage, V_{ID} (see Note 2) . . . . . $\pm V_{DD}$
Input voltage, V_I (any input, see Note 1): C and I suffix . . . . . –0.3 V to V_{DD}
Input current, I_I (each input) . . . . . ±5 mA
Output current, I_O . . . . . ±50 mA
Total current into V_{DD+} . . . . . ±50 mA
Total current out of V_{DD-} . . . . . ±50 mA
Duration of short-circuit current at (or below) 25°C (see Note 3) . . . . . unlimited
Continuous total power dissipation . . . . . See Dissipation Rating Table
Operating free-air temperature range, T_A: C suffix . . . . . 0°C to 70°C
I suffix . . . . . –40°C to 85°C
Q suffix . . . . . –40°C to 125°C
M suffix . . . . . –55°C to 125°C
Storage temperature range, T_{stg} . . . . . –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds . . . . . 260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{DD+} and V_{DD-}.
2. Differential voltages are at IN+ with respect to IN–. Excessive current flows if input is brought below V_{DD-} – 0.3 V.
3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE T_A = 25°C	T_A = 70°C POWER RATING	T_A = 85°C POWER RATING	T_A = 125°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW	145 mW
FK	1375 mW	11.0 mW/°C	880 mW	715 mW	275 mW
JG	1050 mW	8.4 mW/°C	672 mW	546 mW	210 mW
PW	525 mW	4.2 mW/°C	336 mW	273 mW	105 mW
U	675 mW	5.4 mW/°C	432 mW	350 mW	135 mW

recommended operating conditions

	C SUFFIX		I SUFFIX		Q SUFFIX		M SUFFIX		UNIT
	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
Supply voltage, $V_{DD\pm}$	2.7	10	2.7	10	2.7	10	2.7	10	V
Input voltage range, V_I	V_{DD-}	V_{DD+} –0.8	V_{DD-}	V_{DD+} –0.8	V_{DD-}	V_{DD+} –0.8	V_{DD-}	V_{DD+} –0.8	V
Common-mode input voltage, V_{IC}	V_{DD-}	V_{DD+} –0.8	V_{DD-}	V_{DD+} –0.8	V_{DD-}	V_{DD+} –0.8	V_{DD-}	V_{DD+} –0.8	V
Operating free-air temperature, T_A	0	70	–40	85	–40	125	–55	125	°C

electrical characteristics at specified free-air temperature, V_{DD} = 3 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T_A†	TLV2422C MIN	TLV2422C TYP	TLV2422C MAX	UNIT
V_{IO}	Input offset voltage	V_{IC} = 0, V_O = 0,	$V_{DD}\pm = \pm2.5$ V, R_S = 50 Ω	25°C		300	2000	µV
				Full range			2500	
α_{VIO}	Temperature coefficient of input offset voltage			25°C to 70°C		2		µV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.003		µV/mo
I_{IO}	Input offset current			25°C		0.5	60	pA
				Full range			150	
I_{IB}	Input bias current			25°C		1	60	pA
				Full range			150	
V_{ICR}	Common-mode input voltage range	$\|V_{IO}\| \le 5$ mV,	R_S = 50 Ω	25°C	0 to 2.5	–0.25 to 2.75		V
				Full range	0 to 2.2			
V_{OH}	High-level output voltage	I_{OH} = –100 µA		25°C		2.97		V
		I_{OH} = –500 µA		25°C		2.75		
				Full range	2.5			
V_{OL}	Low-level output voltage	V_{IC} = 0,	I_{OL} = 100 µA	25°C		0.05		V
		V_{IC} = 0,	I_{OL} = 250 µA	25°C		0.2		
				Full range			0.5	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 2.5 V, V_O = 1 V to 2 V	R_L = 10 kΩ‡	25°C	6	10		V/mV
				Full range	3			
			R_L = 1 MΩ‡	25°C		700		
$r_{i(d)}$	Differential input resistance			25°C		10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance			25°C		10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz		25°C		8		pF
z_o	Closed-loop output impedance	f = 100 kHz,	A_V = 10	25°C		130		Ω
CMRR	Common-mode rejection ratio	V_{IC} = 0 to 2.5 V, R_S = 50 Ω	V_O = 1.5 V,	25°C	70	83		dB
				Full range	70			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{DD} = 2.7 V to 8 V, $V_{IC} = V_{DD}/2$,	No load	25°C	80	95		dB
				Full range	80			
I_{DD}	Supply current	V_O = 1.5 V,	No load	25°C		100	150	µA
				Full range			175	

† Full range is 0°C to 70°C.
‡ Referenced to 2.5 V

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

electrical characteristics at specified free-air temperature, V_{DD} = 3 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T_A†	TLV2422I			TLV2422AI			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_{IC} = 0, V_O = 0,	$V_{DD}\pm$ = ±2.5 V, R_S = 50 Ω	25°C		300	2000		300	950	μV
				Full range			2500			1500	
α_{VIO}	Temperature coefficient of input offset voltage			25°C to 70°C		2			2		μV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.003			0.003		μV/mo
I_{IO}	Input offset current			25°C		0.5	60		0.5	60	pA
				Full range			150			150	
I_{IB}	Input bias current			25°C		1	60		1	60	pA
				Full range			150			150	
V_{ICR}	Common-mode input voltage range	$\|V_{IO}\|$ ≤ 5 mV,	R_S = 50 Ω	25°C	0 to 2.5	–0.25 to 2.75		0 to 2.5	–0.25 to 2.75		V
				Full range	0 to 2.2			0 to 2.2			
V_{OH}	High-level output voltage	I_{OH} = –100 μA		25°C		2.97			2.97		V
		I_{OH} = –500 μA		25°C		2.75			2.75		
				Full range	2.5			2.5			
V_{OL}	Low-level output voltage	V_{IC} = 0,	I_{OL} = 100 μA	25°C		0.05			0.05		V
		V_{IC} = 0,	I_{OL} = 250 μA	25°C		0.2			0.2		
				Full range			0.5			0.5	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 2.5 V, V_O = 1 V to 2 V	R_L = 10 kΩ‡	25°C	6	10		6	10		V/mV
				Full range	3			3			
			R_L = 1 MΩ‡	25°C		700			700		
$r_{i(d)}$	Differential input resistance			25°C		10^{12}			10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance			25°C		10^{12}			10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz		25°C		8			8		pF
z_o	Closed-loop output impedance	f = 100 kHz,	A_V = 10	25°C		130			130		Ω
CMRR	Common-mode rejection ratio	V_{IC} = 0 to 2.5 V, R_S = 50 Ω	V_O = 1.5 V,	25°C	70	83		70	83		dB
				Full range	70			70			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{DD} = 2.7 V to 8 V, V_{IC} = V_{DD}/2,	No load	25°C	80	95		80	95		dB
				Full range	80			80			
I_{DD}	Supply current	V_O = 1.5 V,	No load	25°C		100	150		100	150	μA
				Full range			175			175	

† Full range is – 40°C to 85°C.
‡ Referenced to 2.5 V
NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, V_{DD} = 3 V

PARAMETER		TEST CONDITIONS		T_A†	TLV2422C, TLV2422I TLV2422AI MIN	TYP	MAX	UNIT
SR	Slew rate at unity gain	V_O = 1.5 V to 3.5 V, C_L = 100 pF‡	R_L = 10 kΩ‡,	25°C	0.01	0.02		V/μs
				Full range	0.008			
V_n	Equivalent input noise voltage	f = 10 Hz		25°C		100		nV/√Hz
		f = 1 kHz		25°C		23		
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 1 Hz		25°C		2.7		μV
		f = 0.1 Hz to 10 Hz		25°C		4		
I_n	Equivalent input noise current			25°C		0.6		fA√Hz
THD + N	Total harmonic distortion plus noise	V_O = 0.5 V to 2.5 V, f = 1 kHz, R_L = 10 kΩ‡	A_V = 1	25°C		0.25%		
			A_V = 10			1.8%		
	Gain-bandwidth product	f = 10 kHz, C_L = 100 pF‡	R_L = 10 kΩ‡,	25°C		46		kHz
B_{OM}	Maximum output-swing bandwidth	$V_{O(PP)}$ = 1 V, R_L = 10 kΩ‡,	A_V = 1, C_L = 100 pF‡	25°C		8.3		kHz
t_s	Settling time	A_V = –1, Step = 0.5 V to 2.5 V, R_L = 10 kΩ‡, C_L = 100 pF‡	To 0.1%	25°C		8.6		μs
			To 0.01%			16		
ϕ_m	Phase margin at unity gain	R_L = 10 kΩ‡,	C_L = 100 pF‡	25°C		62°		
	Gain margin			25°C		11		dB

† Full range for the C version is 0°C to 70°C. Full range for the I version is –40°C to 85°C.
‡ Referenced to 2.5 V

electrical characteristics at specified free-air temperature, V_{DD} = 3 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T_A†	TLV2422Q, TLV2422M			TLV2422AQ, TLV2422AM			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_{IC} = 0, V_O = 0,	$V_{DD}\pm$ = ±1.5 V, R_S = 50 Ω	25°C		300	2000		300	950	µV
				Full range			2500			1800	
α_{VIO}	Temperature coefficient of input offset voltage			Full range		2			2		µV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.003			0.003		µV/mo
I_{IO}	Input offset current			25°C		0.5	60		0.5	60	pA
				Full range			150			150	
I_{IB}	Input bias current			25°C		1	60		1	60	pA
				Full range			300			300	
V_{ICR}	Common-mode input voltage range	$\vert V_{IO}\vert \le$ 5 mV,	R_S = 50 Ω	25°C	0 to 2.5	–0.25 to 2.75		0 to 2.5	–0.25 to 2.75		V
				Full range	0 to 2.2			0 to 2.2			
V_{OH}	High-level output voltage	I_{OH} = –100 µA		25°C		2.97			2.97		V
		I_{OH} = –500 µA		25°C		2.75			2.75		
				Full range	2.5			2.5			
V_{OL}	Low-level output voltage	V_{IC} = 0,	I_{OL} = 100 µA	25°C		0.05			0.05		V
		V_{IC} = 0,	I_{OL} = 250 µA	25°C		0.2			0.2		
				Full range			0.5			0.5	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 1.5 V, V_O = 1 V to 2 V	R_L = 10 kΩ‡	25°C	6	10		6	10		V/mV
				Full range	2			2			
			R_L = 1 MΩ‡	25°C		700			700		
$r_{i(d)}$	Differential input resistance			25°C		10^{12}			10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance			25°C		10^{12}			10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz		25°C		8			8		pF
z_o	Closed-loop output impedance	f = 100 kHz,	A_V = 10	25°C		130			130		Ω
CMRR	Common-mode rejection ratio	$V_{IC} = V_{ICR}$ min, R_S = 50 Ω	V_O = 1.5 V,	25°C	70	83		70	83		dB
				Full range	70			70			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{DD} = 2.7 V to 8 V, $V_{IC} = V_{DD}/2$,	No load	25°C	80	95		80	95		dB
				Full range	80			80			
I_{DD}	Supply current	V_O = 1.5 V,	No load	25°C		100	150		100	150	µA
				Full range			175			175	

† Full range is –40°C to 125°C for Q level part, –55°C to 125°C for M level part.
‡ Referenced to 1.5 V
NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, V_{DD} = 3 V

PARAMETER		TEST CONDITIONS		T_A†	TLV2422Q, TLV2422M, TLV2422AQ, TLV2422AM MIN	TYP	MAX	UNIT
SR	Slew rate at unity gain	V_O = 1.1 V to 1.9 V, C_L = 100 pF‡	R_L = 10 kΩ‡,	25°C	0.01	0.02		V/µs
				Full range	0.008			
V_n	Equivalent input noise voltage	f = 10 Hz		25°C		100		nV/√Hz
		f = 1 kHz		25°C		23		
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 1 Hz		25°C		2.7		µV
		f = 0.1 Hz to 10 Hz		25°C		4		
I_n	Equivalent input noise current			25°C		0.6		fA√Hz
THD + N	Total harmonic distortion plus noise	V_O = 0.5 V to 2.5 V, f = 1 kHz, R_L = 10 kΩ‡	A_V = 1	25°C		0.25%		
			A_V = 10			1.8%		
	Gain-bandwidth product	f = 10 kHz, C_L = 100 pF‡	R_L = 10 kΩ‡,	25°C		46		kHz
B_{OM}	Maximum output-swing bandwidth	$V_{O(PP)}$ = 1 V, R_L = 10 kΩ‡,	A_V = 1, C_L = 100 pF‡	25°C		8.3		kHz
t_s	Settling time	A_V = –1, Step = 0.5 V to 2.5 V, R_L = 10 kΩ‡, C_L = 100 pF‡	To 0.1%	25°C		8.6		µs
			To 0.01%			16		
ϕ_m	Phase margin at unity gain	R_L = 10 kΩ‡,	C_L = 100 pF‡	25°C		62°		
	Gain margin			25°C		11		dB

† Full range is –40°C to 125°C for Q level part, –55°C to 125°C for M level part.
‡ Referenced to 1.5 V

electrical characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A†	TLV2422C MIN	TLV2422C TYP	TLV2422C MAX	UNIT
V_{IO}	Input offset voltage	V_{IC} = 0, V_O = 0, $V_{DD}\pm$ = ±2.5 V, R_S = 50 Ω	25°C		300	2000	µV
			Full range			2500	
α_{VIO}	Temperature coefficient of input offset voltage		25°C to 70°C		2		µV/°C
	Input offset voltage long-term drift (see Note 4)		25°C		0.003		µV/mo
I_{IO}	Input offset current		25°C		0.5	60	pA
			Full range			150	
I_{IB}	Input bias current		25°C		1	60	pA
			Full range			150	
V_{ICR}	Common-mode input voltage range	$\|V_{IO}\| \le$ 5 mV, R_S = 50 Ω	25°C	0 to 4.5	–0.25 to 4.75		V
			Full range	0 to 4.2			
V_{OH}	High-level output voltage	I_{OH} = –100 µA	25°C		4.97		V
		I_{OH} = –1 mA	25°C	4.5	4.75		
			Full range	4.25			
V_{OL}	Low-level output voltage	V_{IC} = 2.5 V, I_{OL} = 100 µA	25°C		0.04		V
		V_{IC} = 2.5 V, I_{OL} = 500 µA	25°C		0.15		
			Full range			0.5	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 2.5 V, V_O = 1 V to 4 V, R_L = 10 kΩ‡	25°C	8	12		V/mV
			Full range	5			
		V_{IC} = 2.5 V, V_O = 1 V to 4 V, R_L = 1 MΩ‡	25°C		1000		
$r_{i(d)}$	Differential input resistance		25°C		10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance		25°C		10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz	25°C		8		pF
z_o	Closed-loop output impedance	f = 100 kHz, A_V = 10	25°C		130		Ω
CMRR	Common-mode rejection ratio	V_{IC} = 0 to 4.5 V, V_O = 2.5 V, R_S = 50 Ω	25°C	70	90		dB
			Full range	70			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{DD} = 4.4 V to 8 V, $V_{IC} = V_{DD}/2$, No load	25°C	80	95		dB
			Full range	80			
I_{DD}	Supply current	V_O = 2.5 V, No load	25°C		100	150	µA
			Full range			175	

† Full range is 0°C to 70°C.
‡ Referenced to 2.5 V

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

electrical characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T_A†	TLV2422I			TLV2422AI			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_{IC} = 0, V_O = 0,	$V_{DD}\pm$ = ±2.5 V, R_S = 50 Ω	25°C		300	2000		300	950	µV
				Full range			2500			1500	
α_{VIO}	Temperature coefficient of input offset voltage			25°C to 70°C		2			2		µV/°C
	Input offset voltage long-term drift (see Note 4)			25°C		0.003			0.003		µV/mo
I_{IO}	Input offset current			25°C		0.5	60		0.5	60	pA
				Full range			150			150	
I_{IB}	Input bias current			25°C		1	60		1	60	pA
				Full range			150			150	
V_{ICR}	Common-mode input voltage range	$\lvert V_{IO}\rvert \le$ 5 mV,	R_S = 50 Ω	25°C	0 to 4.5	–0.25 to 4.75		0 to 4.5	–0.25 to 4.75		V
				Full range	0 to 4.2			0 to 4.2			
V_{OH}	High-level output voltage	I_{OH} = –100 µA		25°C		4.97			4.97		V
		I_{OH} = –1 mA		25°C	4.5	4.75		4.5	4.75		
				Full range	4.25			4.25			
V_{OL}	Low-level output voltage	V_{IC} = 2.5 V,	I_{OL} = 100 µA	25°C		0.04			0.04		V
		V_{IC} = 2.5 V,	I_{OL} = 500 µA	25°C		0.15			0.15		
				Full range			0.5			0.5	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 2.5 V, V_O = 1 V to 4 V	R_L = 10 kΩ‡	25°C	8	12		8	12		V/mV
				Full range	5			5			
			R_L = 1 MΩ‡	25°C		1000			1000		
$r_{i(d)}$	Differential input resistance			25°C		10^{12}			10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance			25°C		10^{12}			10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz		25°C		8			8		pF
z_o	Closed-loop output impedance	f = 100 kHz,	A_V = 10	25°C		130			130		Ω
CMRR	Common-mode rejection ratio	V_{IC} = 0 to 4.5 V, R_S = 50 Ω	V_O = 2.5 V,	25°C	70	90		70	90		dB
				Full range	70			70			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{DD} = 4.4 V to 8 V, V_{IC} = V_{DD}/2,	No load	25°C	80	95		80	95		dB
				Full range	80			80			
I_{DD}	Supply current	V_O = 2.5 V,	No load	25°C		100	150		100	150	µA
				Full range			175			175	

† Full range is – 40°C to 85°C.
‡ Referenced to 2.5 V
NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, V_{DD} = 5 V

PARAMETER		TEST CONDITIONS		T_A†	TLV2422C, TLV2422I TLV2422AI MIN	TYP	MAX	UNIT
SR	Slew rate at unity gain	V_O = 1.5 V to 3.5 V, C_L = 100 pF‡	R_L = 10 kΩ‡,	25°C	0.01	0.02		V/μs
				Full range	0.008			
V_n	Equivalent input noise voltage	f = 10 Hz		25°C		100		nV/√Hz
		f = 1 kHz		25°C		18		
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 1 Hz		25°C		1.9		μV
		f = 0.1 Hz to 10 Hz		25°C		2.8		
I_n	Equivalent input noise current			25°C		0.6		fA√Hz
THD + N	Total harmonic distortion plus noise	V_O = 1.5 V to 3.5 V, f = 1 kHz, R_L = 10 kΩ‡	A_V = 1	25°C		0.24%		
			A_V = 10			1.7%		
	Gain-bandwidth product	f = 10 kHz, C_L = 100 pF‡	R_L =10 kΩ‡,	25°C		52		kHz
B_{OM}	Maximum output-swing bandwidth	$V_{O(PP)}$ = 2 V, R_L = 10 kΩ‡,	A_V = 1, C_L = 100 pF‡	25°C		5.3		kHz
t_s	Settling time	A_V = –1, Step = 1.5 V to 3.5 V, R_L = 10 kΩ‡, C_L = 100 pF‡	To 0.1%	25°C		8.5		μs
			To 0.01%			15.5		
ϕ_m	Phase margin at unity gain	R_L = 10 kΩ‡,	C_L = 100 pF‡	25°C		66°		
	Gain margin			25°C		11		dB

† Full range for the C version is 0°C to 70°C. Full range for the I version is –40°C to 85°C.
‡ Referenced to 2.5 V

electrical characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A†	TLV2422Q, TLV2422M MIN	TLV2422Q, TLV2422M TYP	TLV2422Q, TLV2422M MAX	TLV2422AQ, TLV2422AM MIN	TLV2422AQ, TLV2422AM TYP	TLV2422AQ, TLV2422AM MAX	UNIT
V_{IO}	Input offset voltage	V_{IC} = 0, V_O = 0, $V_{DD}\pm$ = ±2.5 V, R_S = 50 Ω	25°C		300	2000		300	950	µV
			Full range			2500			1800	
α_{VIO}	Temperature coefficient of input offset voltage		Full range		2			2		µV/°C
	Input offset voltage long-term drift (see Note 4)		25°C		0.003			0.003		µV/mo
I_{IO}	Input offset current		25°C		0.5	60		0.5	60	pA
			Full range			150			150	
I_{IB}	Input bias current		25°C		1	60		1	60	pA
			Full range			300			300	
V_{ICR}	Common-mode input voltage range	$\|V_{IO}\| \leq$ 5 mV, R_S = 50 Ω	25°C	0 to 4.5	–0.25 to 4.75		0 to 4.5	–0.25 to 4.75		V
			Full range	0 to 4.2			0 to 4.2			
V_{OH}	High-level output voltage	I_{OH} = –100 µA	25°C		4.97			4.97		V
		I_{OH} = –1 mA	25°C		4.75			4.75		
			Full range	4.5			4.5			
V_{OL}	Low-level output voltage	V_{IC} = 2.5 V, I_{OL} = 100 µA	25°C		0.04			0.04		V
		V_{IC} = 2.5 V, I_{OL} = 500 µA	25°C		0.15			0.15		
			Full range			0.5			0.5	
A_{VD}	Large-signal differential voltage amplification	V_{IC} = 2.5 V, V_O = 1 V to 4 V, R_L = 10 kΩ‡	25°C	8	12		8	12		V/mV
			Full range	3			3			
		R_L = 1 MΩ‡	25°C		1000			1000		
$r_{i(d)}$	Differential input resistance		25°C		10^{12}			10^{12}		Ω
$r_{i(c)}$	Common-mode input resistance		25°C		10^{12}			10^{12}		Ω
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz	25°C		8			8		pF
z_o	Closed-loop output impedance	f = 100 kHz, A_V = 10	25°C		130			130		Ω
CMRR	Common-mode rejection ratio	V_{IC} = V_{ICR} min, V_O = 2.5 V, R_S = 50 Ω	25°C	70	90		70	90		dB
			Full range	70			70			
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	V_{DD} = 4.4 V to 8 V, V_{IC} = V_{DD}/2, No load	25°C	80	95		80	95		dB
			Full range	80			80			
I_{DD}	Supply current	V_O = 2.5 V, No load	25°C		100	150		100	150	µA
			Full range			175			175	

† Full range is –40°C to 125°C for Q level part, –55°C to 125°C for M level part.
‡ Referenced to 2.5 V
NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at T_A = 150°C extrapolated to T_A = 25°C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, V_{DD} = 5 V

PARAMETER		TEST CONDITIONS		T_A†	TLV2422Q, TLV2422M, TLV2422AQ, TLV2422AM MIN	TYP	MAX	UNIT
SR	Slew rate at unity gain	V_O = 1.5 V to 3.5 V, C_L = 100 pF‡	R_L = 10 kΩ‡,	25°C	0.01	0.02		V/µs
				Full range	0.008			
V_n	Equivalent input noise voltage	f = 10 Hz		25°C		100		nV/√Hz
		f = 1 kHz		25°C		18		
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 1 Hz		25°C		1.9		µV
		f = 0.1 Hz to 10 Hz		25°C		2.8		
I_n	Equivalent input noise current			25°C		0.6		fA√Hz
THD + N	Total harmonic distortion plus noise	V_O = 1.5 V to 3.5 V, f = 1 kHz, R_L = 10 kΩ‡	A_V = 1	25°C		0.24%		
			A_V = 10			1.7%		
	Gain-bandwidth product	f = 10 kHz, C_L = 100 pF‡	R_L =10 kΩ‡,	25°C		52		kHz
B_{OM}	Maximum output-swing bandwidth	$V_{O(PP)}$ = 2 V, R_L = 10 kΩ‡,	A_V = 1, C_L = 100 pF‡	25°C		5.3		kHz
t_s	Settling time	A_V = –1, Step = 1.5 V to 3.5 V, R_L = 10 kΩ‡, C_L = 100 pF‡	To 0.1%	25°C		8.5		µs
			To 0.01%			15.5		
ϕ_m	Phase margin at unity gain	R_L = 10 kΩ‡,	C_L = 100 pF‡	25°C		66°		
	Gain margin			25°C		11		dB

† Full range is –40°C to 125°C for Q level part, –55°C to 125°C for M level part.
‡ Referenced to 2.5 V

TYPICAL CHARACTERISTICS

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	Gain margin	vs Load capacitance	49
B_1	Unity-gain bandwidth	vs Load capacitance	50

TYPICAL CHARACTERISTICS

DISTRIBUTION OF TLV2422
INPUT OFFSET VOLTAGE

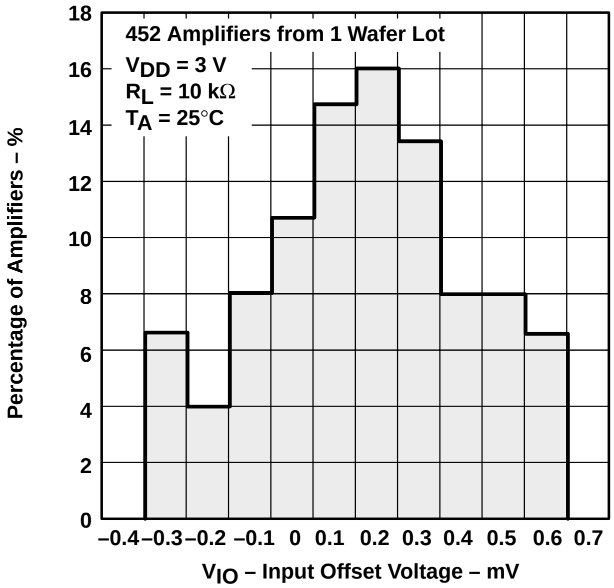

Figure 2

DISTRIBUTION OF TLV2422
INPUT OFFSET VOLTAGE

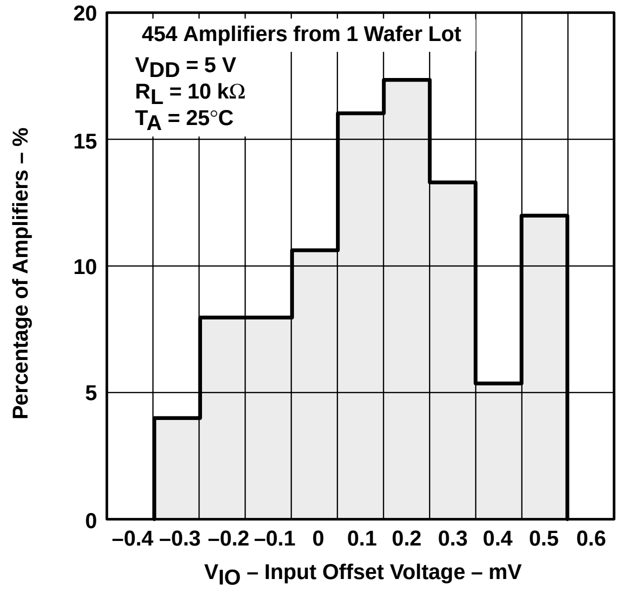

Figure 3

INPUT OFFSET VOLTAGE
vs
COMMON-MODE INPUT VOLTAGE

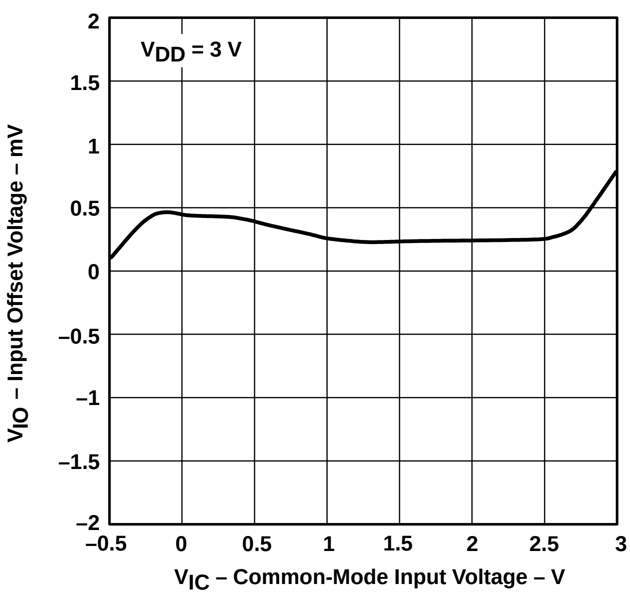

Figure 4

INPUT OFFSET VOLTAGE
vs
COMMON-MODE INPUT VOLTAGE

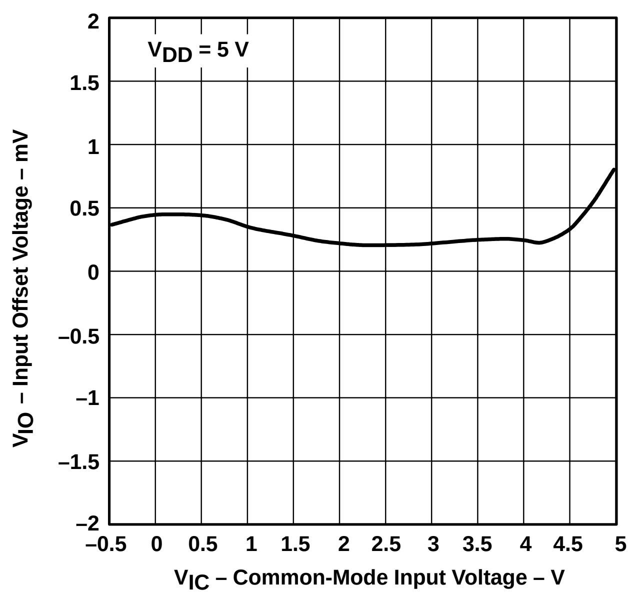

Figure 5

TYPICAL CHARACTERISTICS

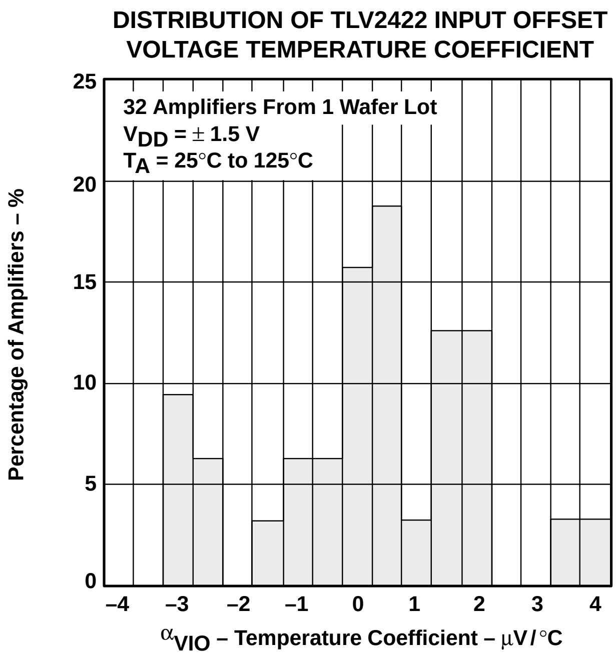

Figure 6

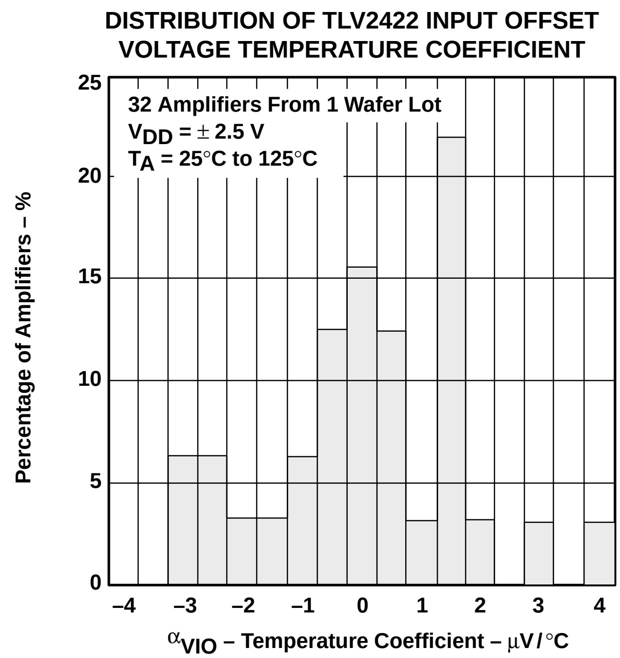

Figure 7

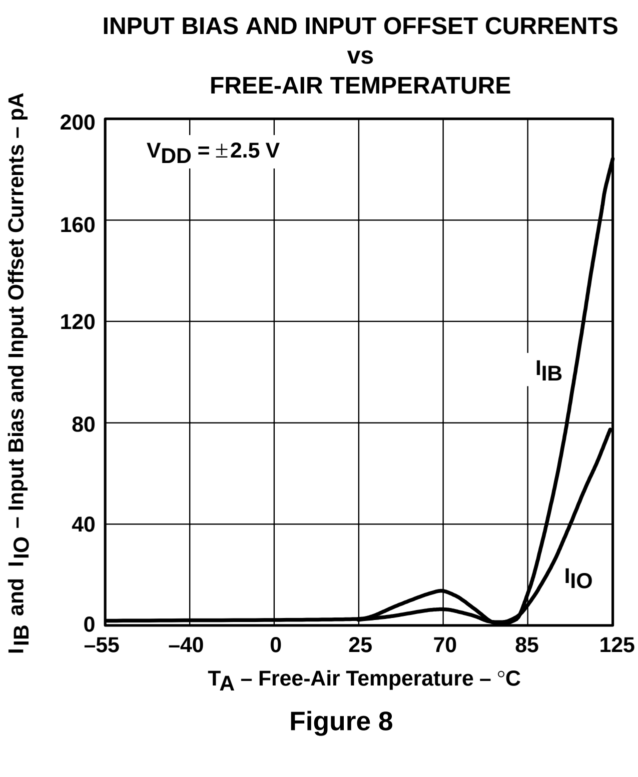

Figure 8

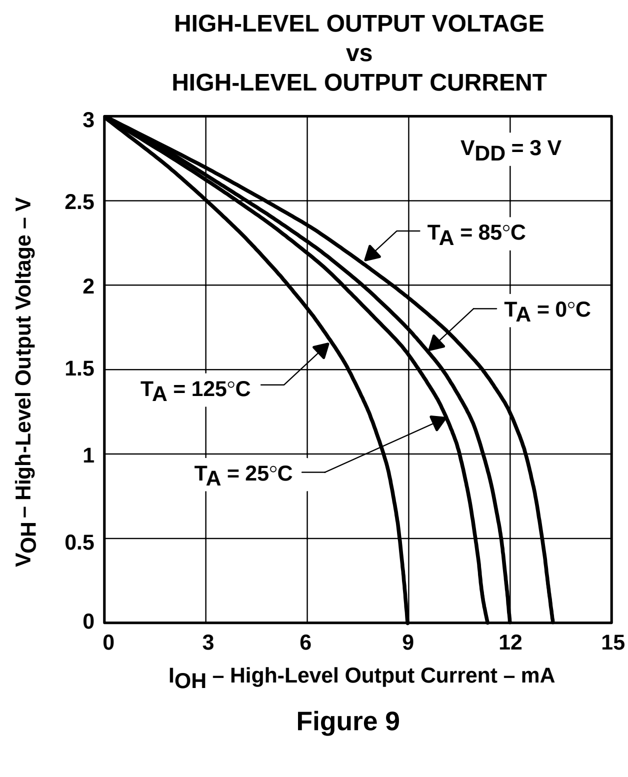

Figure 9

TYPICAL CHARACTERISTICS

LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT

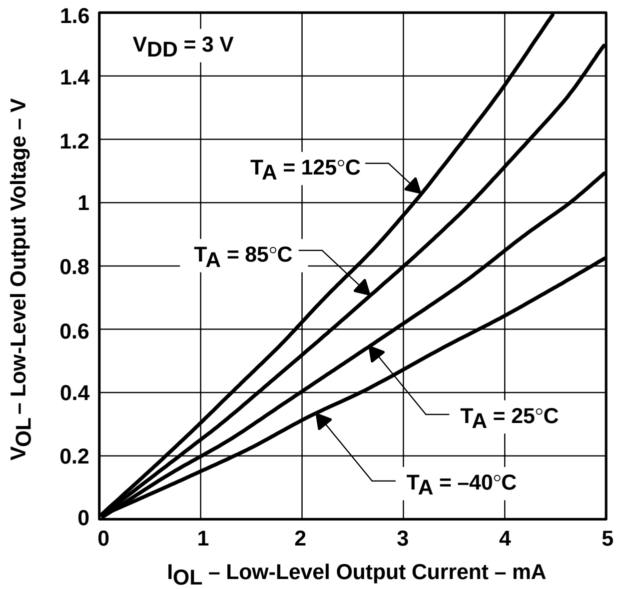

Figure 10

HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

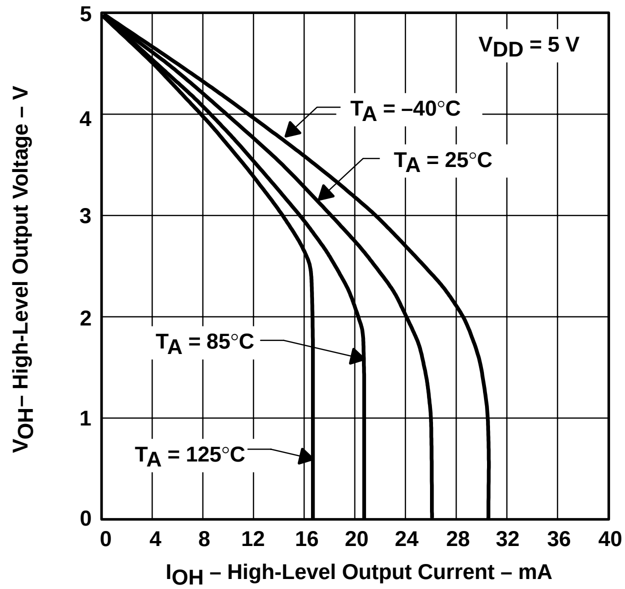

Figure 11

LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT

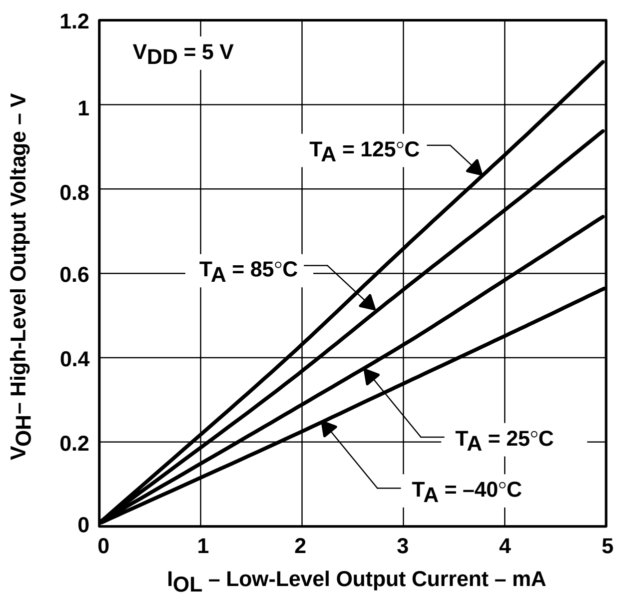

Figure 12

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE
vs
FREQUENCY

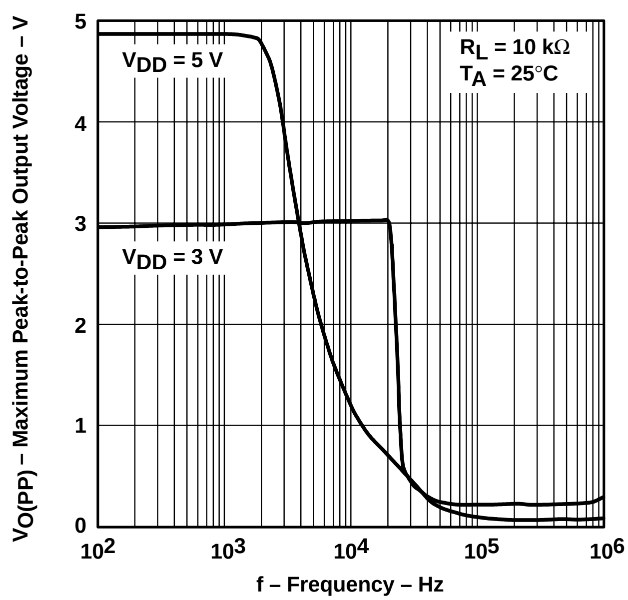

Figure 13

TYPICAL CHARACTERISTICS

SHORT-CIRCUIT OUTPUT CURRENT
vs
SUPPLY VOLTAGE

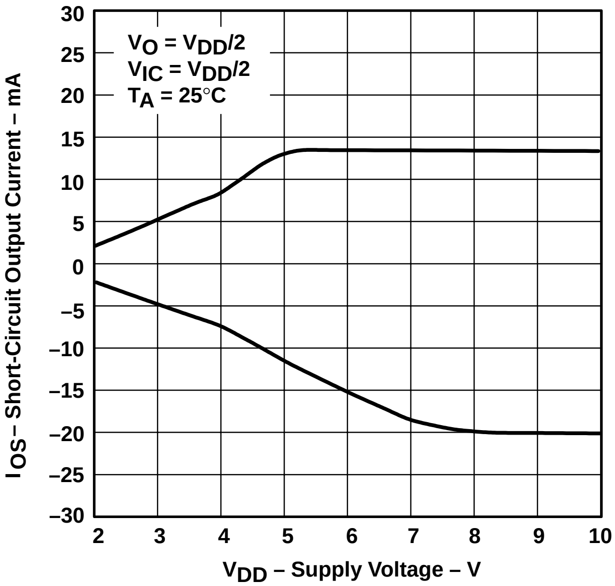

Figure 14

SHORT-CIRCUIT OUTPUT CURRENT
vs
FREE-AIR TEMPERATURE

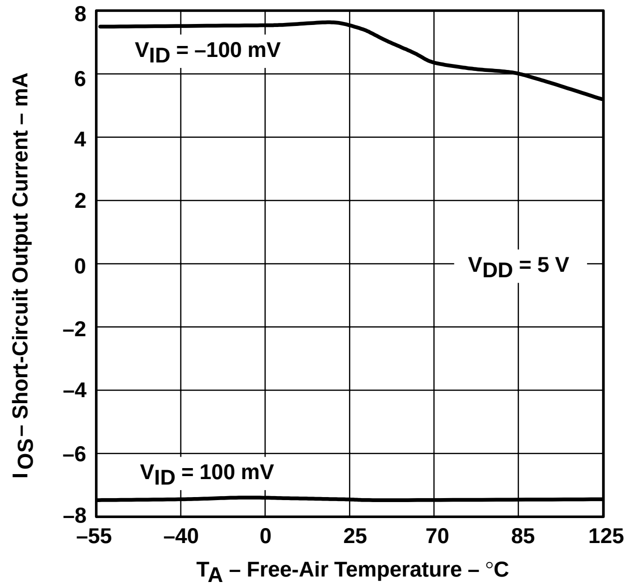

Figure 15

DIFFERENTIAL INPUT VOLTAGE
vs
OUTPUT VOLTAGE

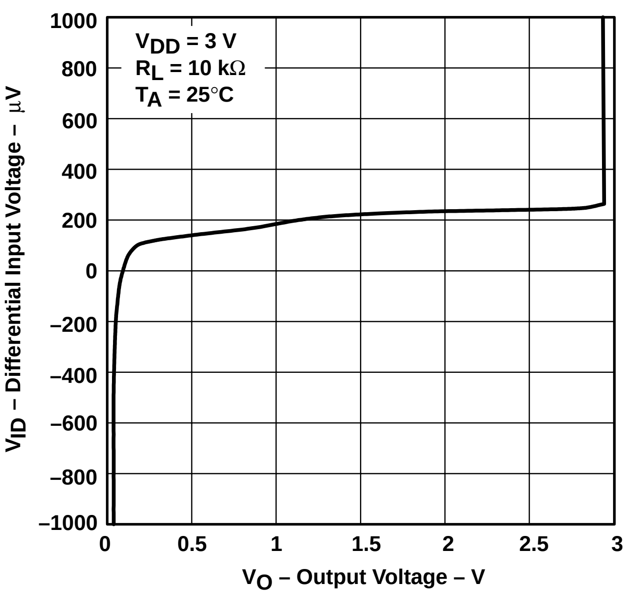

Figure 16

DIFFERENTIAL INPUT VOLTAGE
vs
OUTPUT VOLTAGE

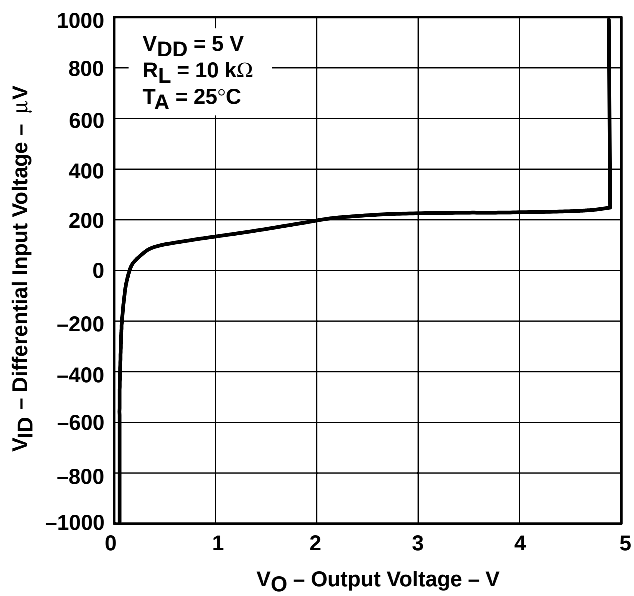

Figure 17

TYPICAL CHARACTERISTICS

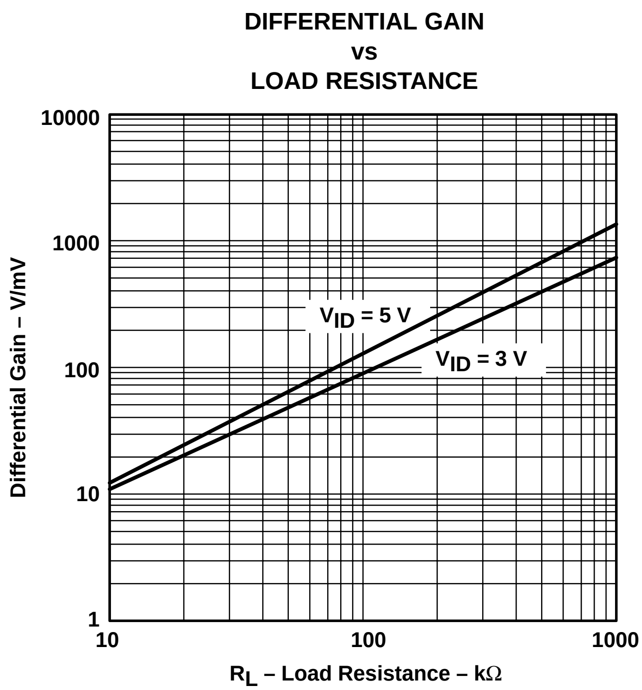

Figure 18

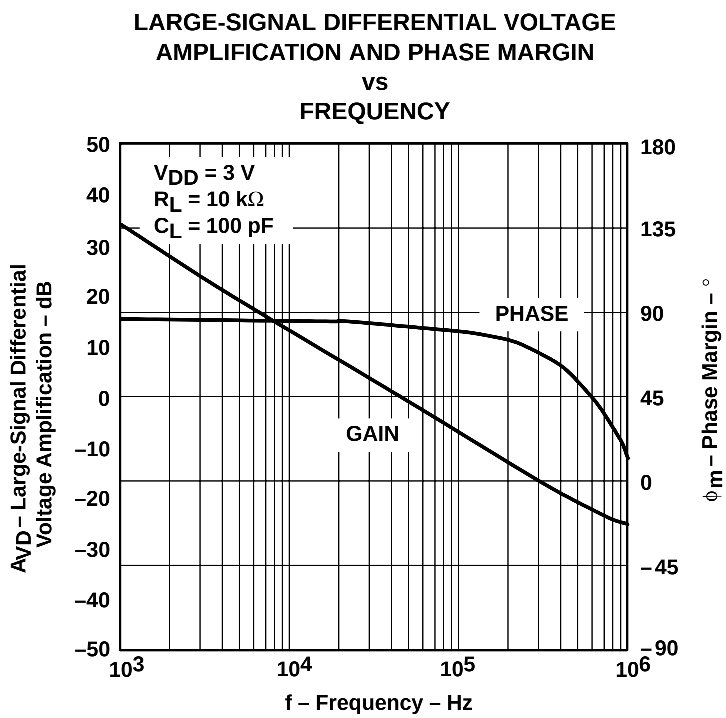

Figure 19

TYPICAL CHARACTERISTICS

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN
vs
FREQUENCY

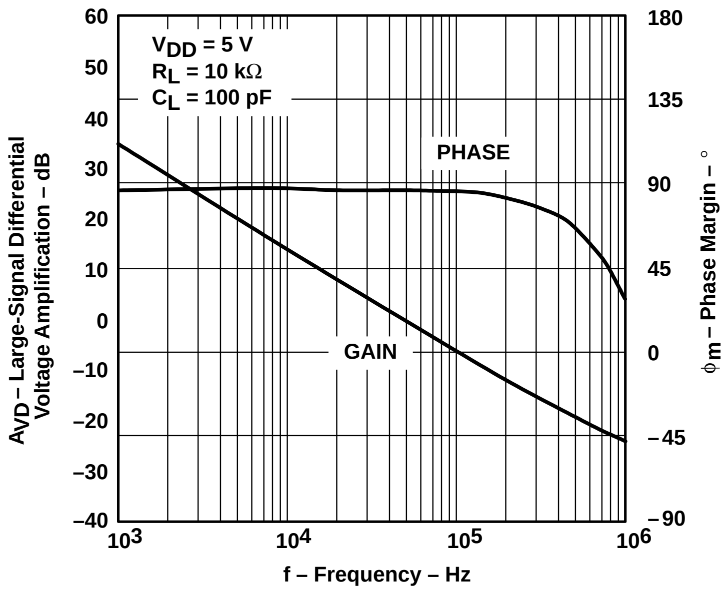

Figure 20

DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
FREE-AIR TEMPERATURE

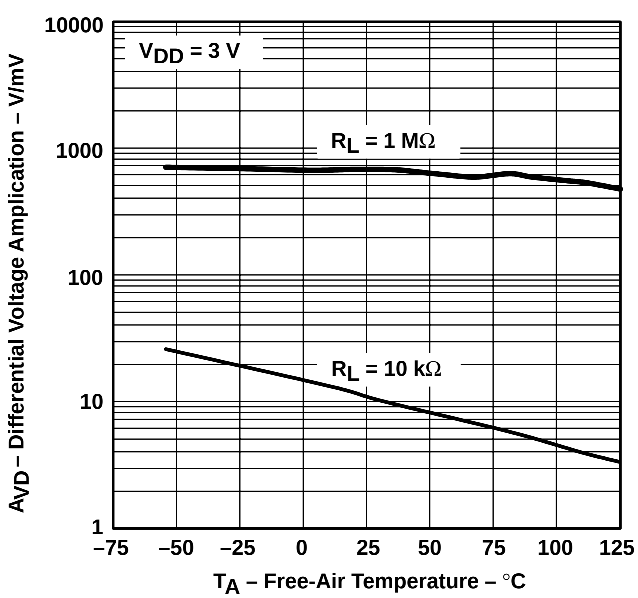

Figure 21

DIFFERENTIAL VOLTAGE AMPLIFICATION
vs
FREE-AIR TEMPERATURE

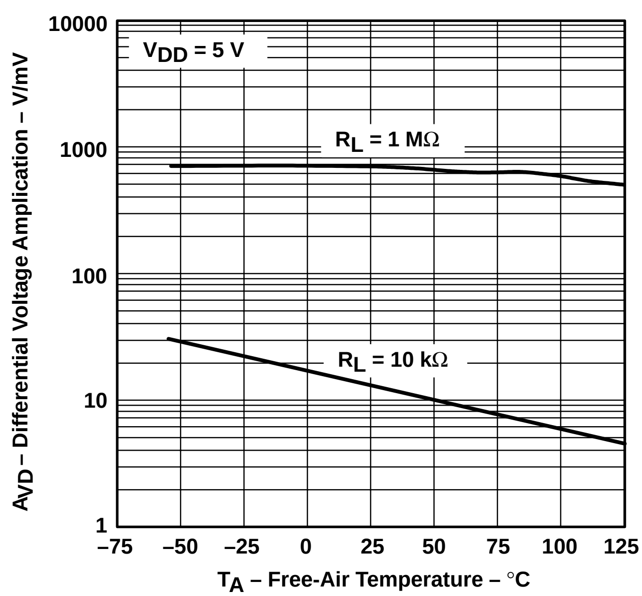

Figure 22

TYPICAL CHARACTERISTICS

OUTPUT IMPEDANCE vs FREQUENCY

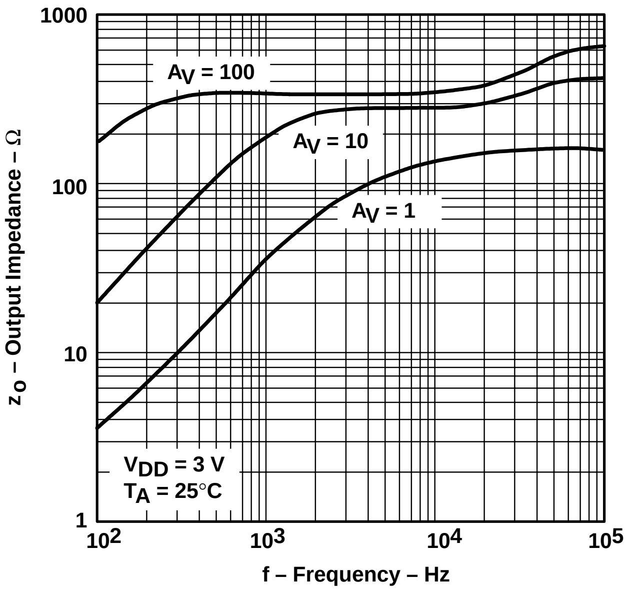

Figure 23

OUTPUT IMPEDANCE vs FREQUENCY

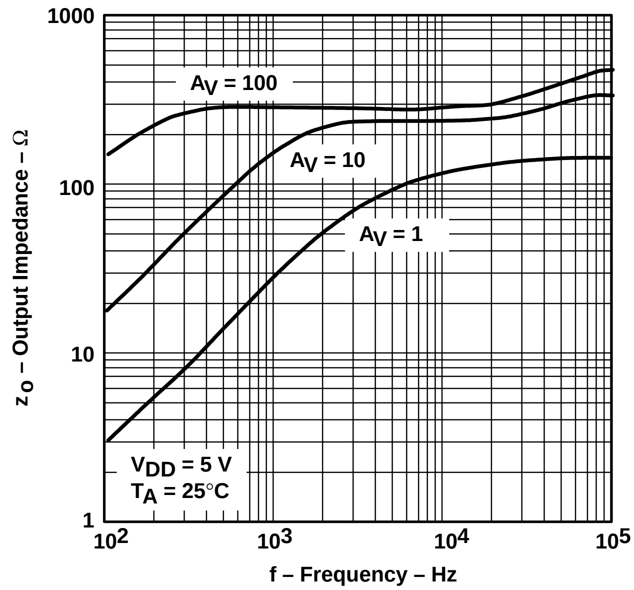

Figure 24

COMMON-MODE REJECTION RATIO vs FREQUENCY

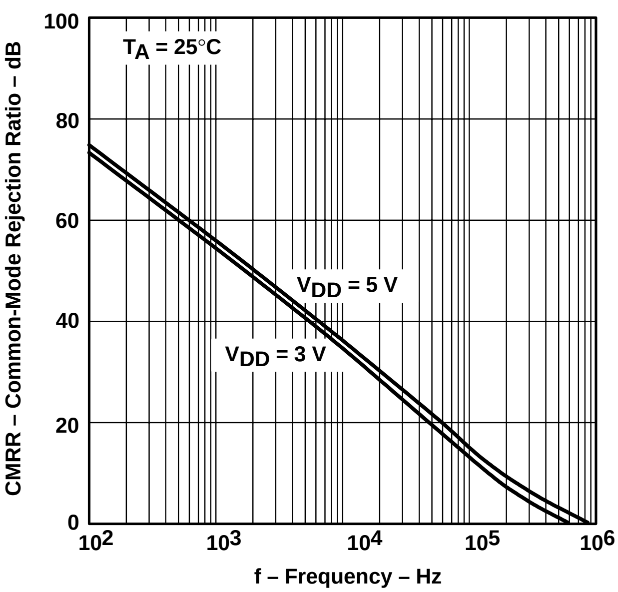

Figure 25

COMMON-MODE REJECTION RATIO vs FREE-AIR TEMPERATURE

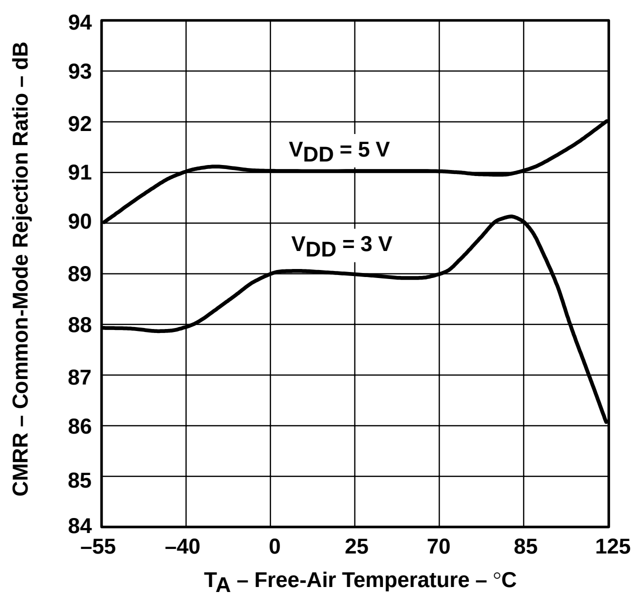

Figure 26

TYPICAL CHARACTERISTICS

SUPPLY-VOLTAGE REJECTION RATIO vs FREQUENCY

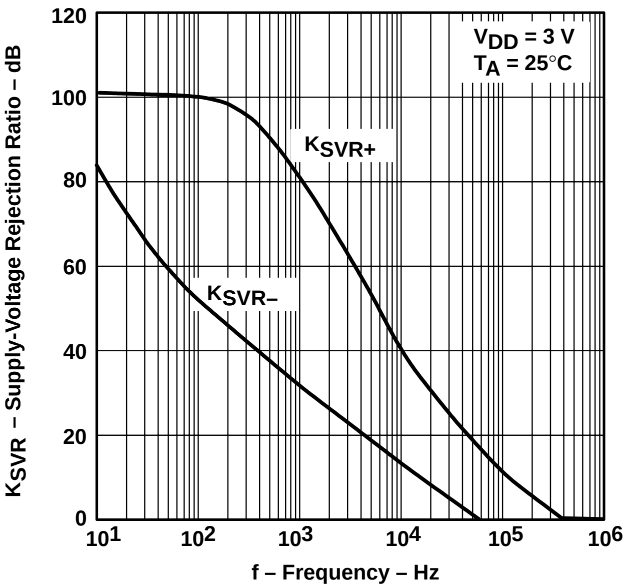

Figure 27

SUPPLY-VOLTAGE REJECTION RATIO vs FREQUENCY

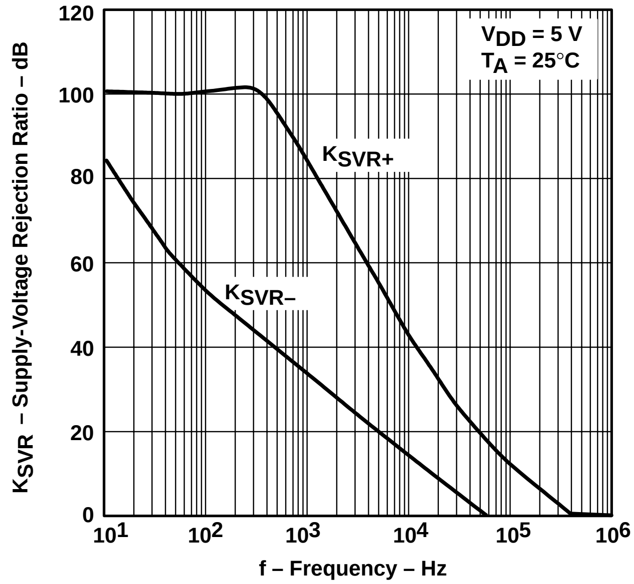

Figure 28

SUPPLY-VOLTAGE REJECTION RATIO vs FREE-AIR TEMPERATURE

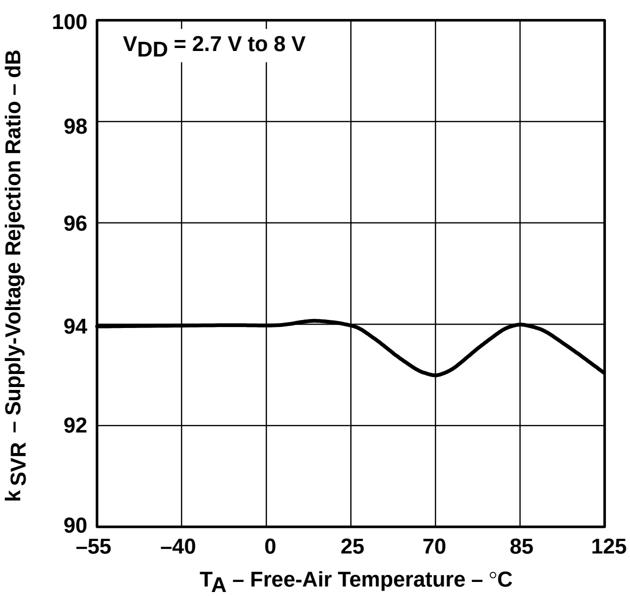

Figure 29

SUPPLY CURRENT vs SUPPLY VOLTAGE

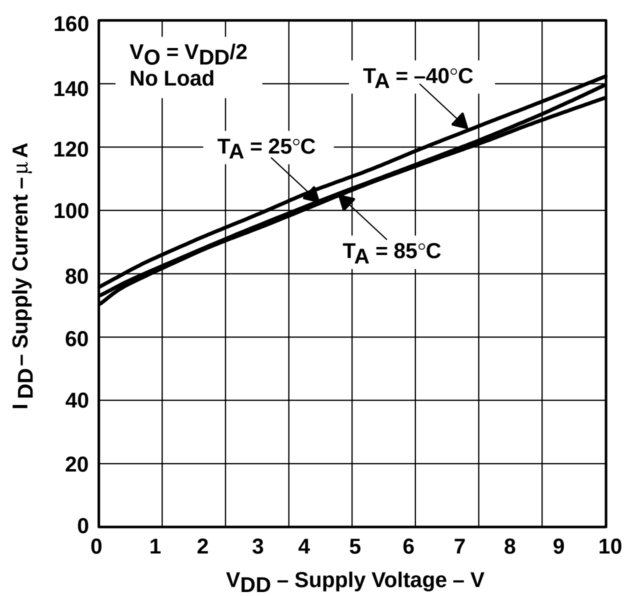

Figure 30

TYPICAL CHARACTERISTICS

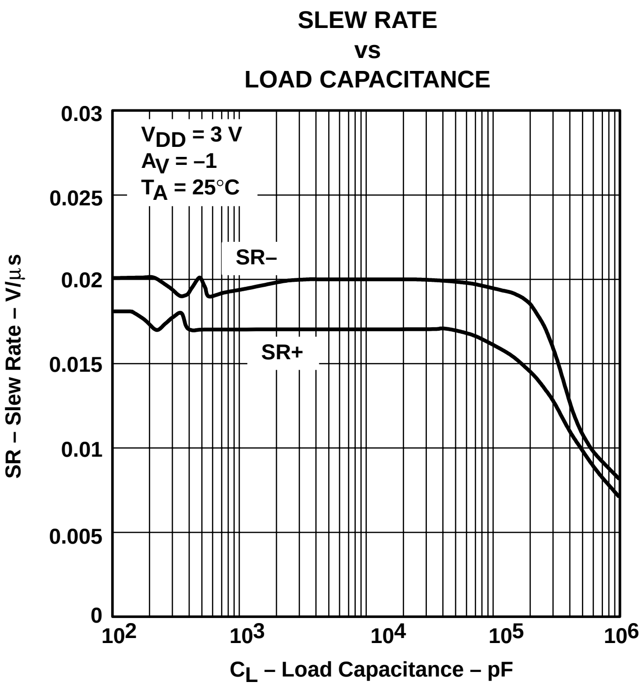

Figure 31

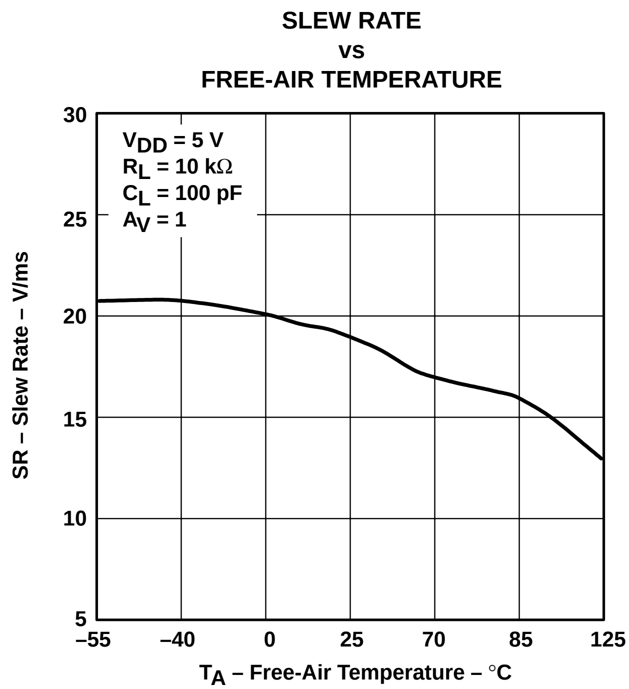

Figure 32

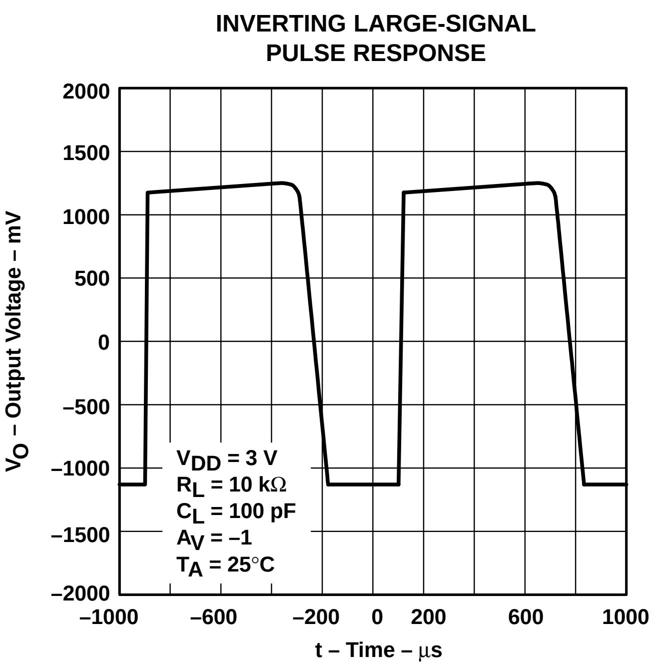

Figure 33

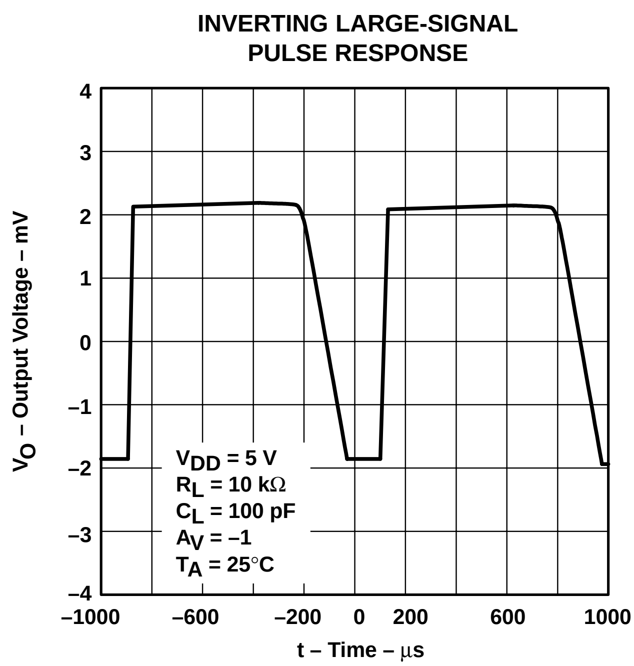

Figure 34

TYPICAL CHARACTERISTICS

VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE

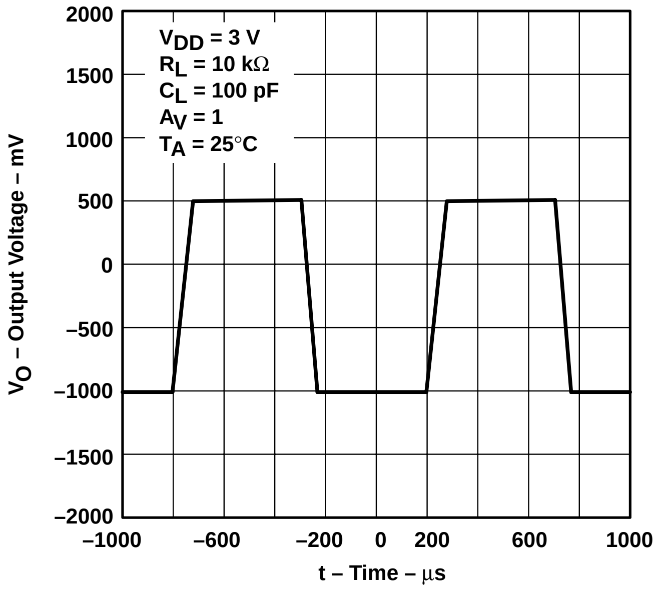

Figure 35

VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE

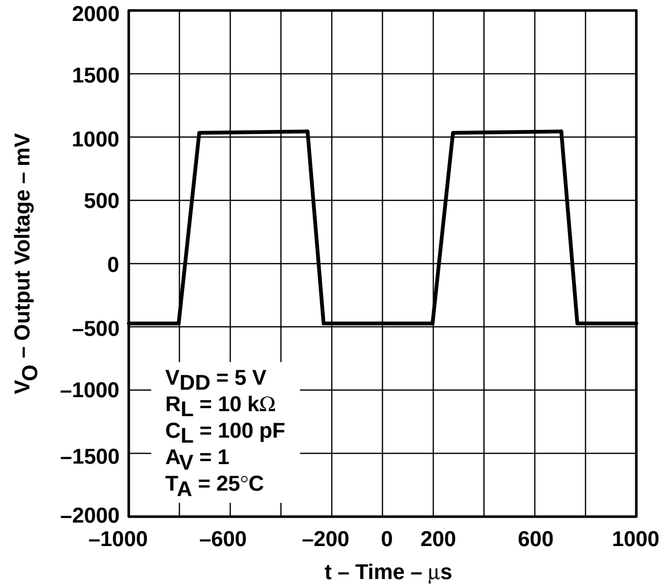

Figure 36

INVERTING SMALL-SIGNAL PULSE RESPONSE

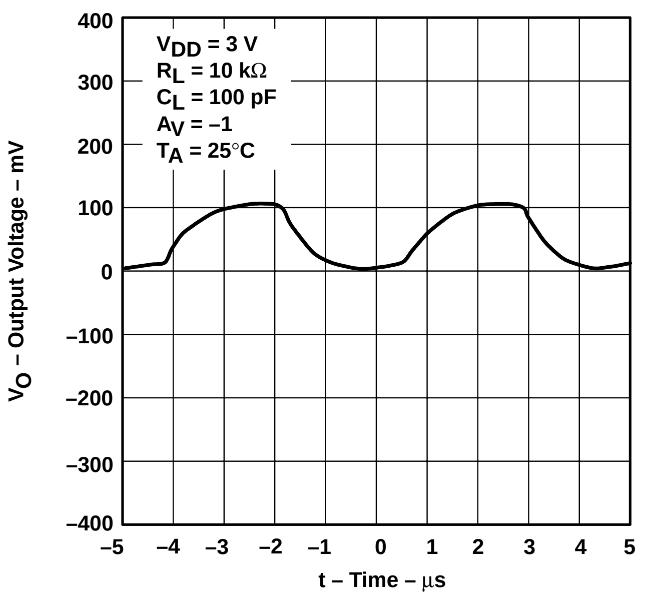

Figure 37

INVERTING SMALL-SIGNAL PULSE RESPONSE

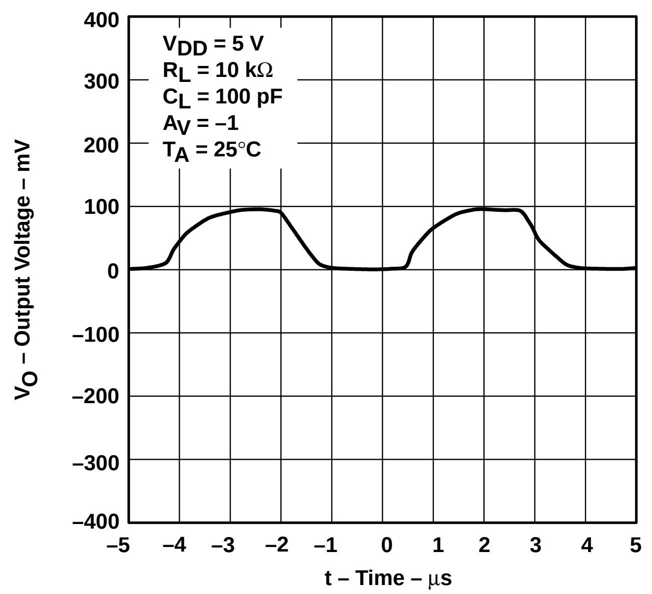

Figure 38

TYPICAL CHARACTERISTICS

VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE

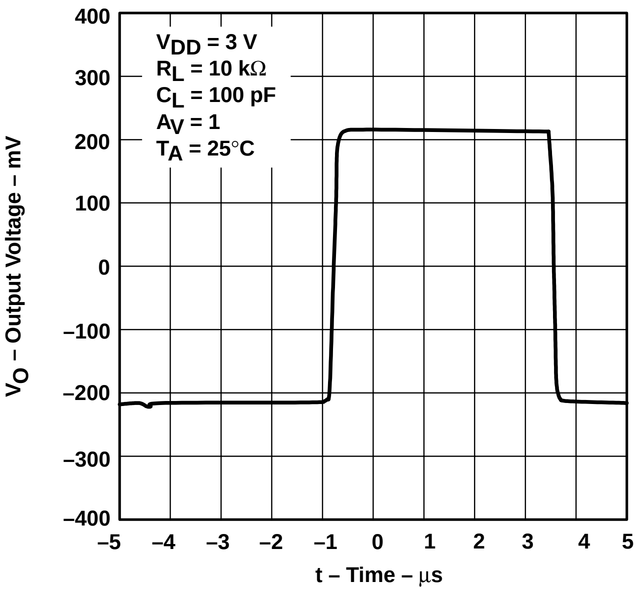

Figure 39

VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE

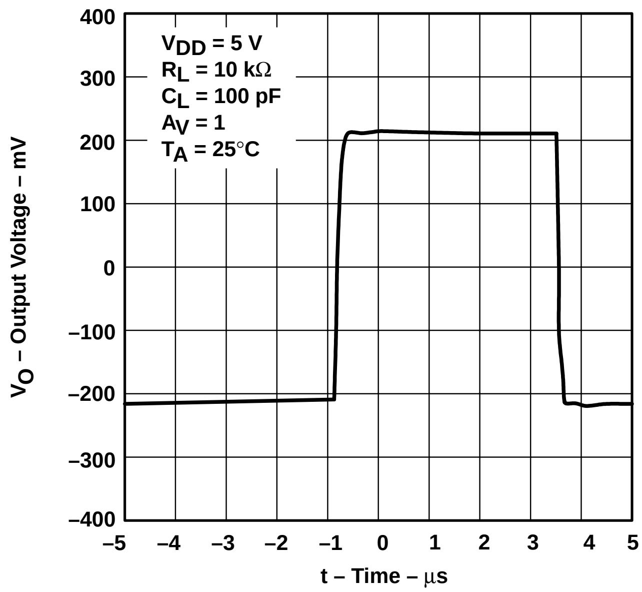

Figure 40

EQUIVALENT INPUT NOISE VOLTAGE vs FREQUENCY

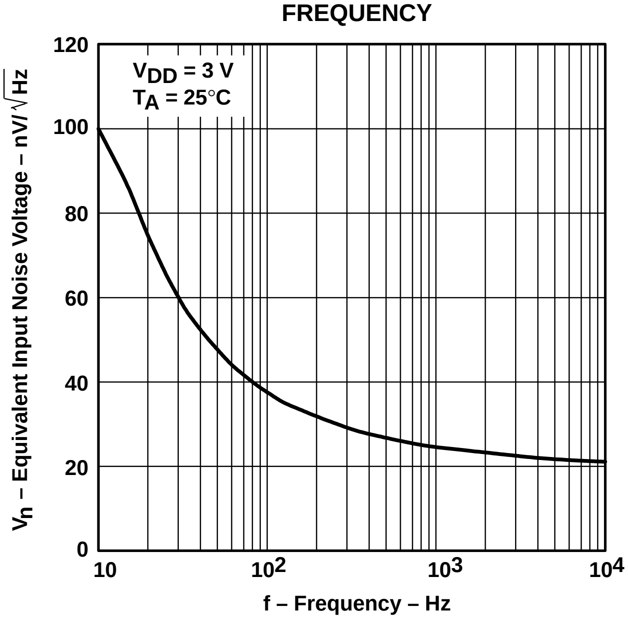

Figure 41

EQUIVALENT INPUT NOISE VOLTAGE vs FREQUENCY

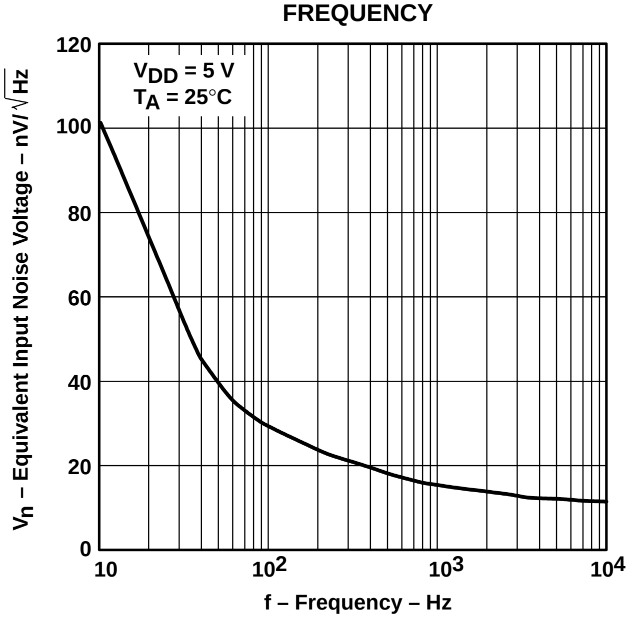

Figure 42

TYPICAL CHARACTERISTICS

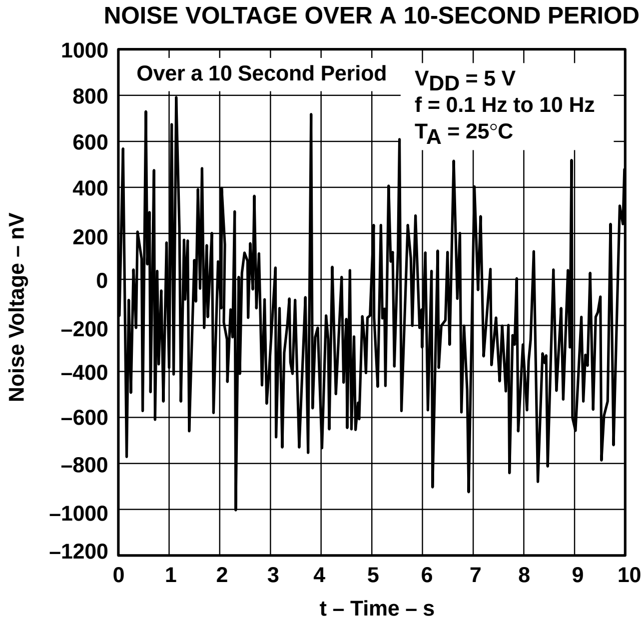

Figure 43

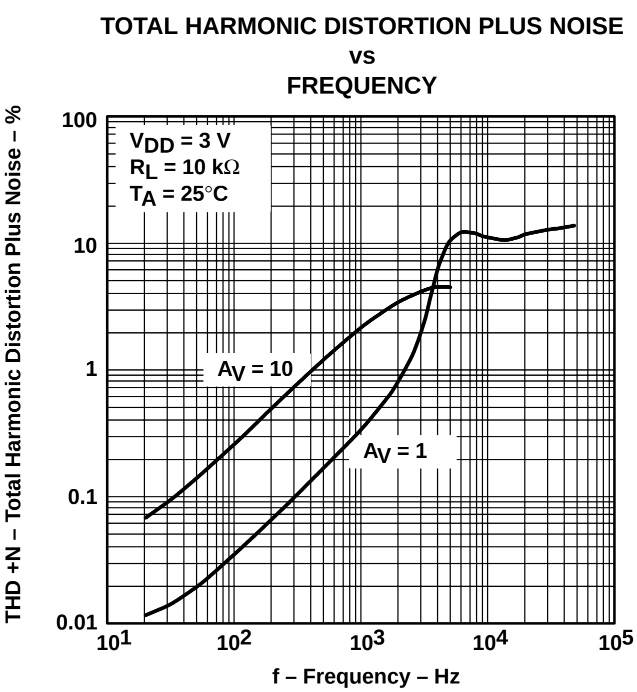

Figure 44

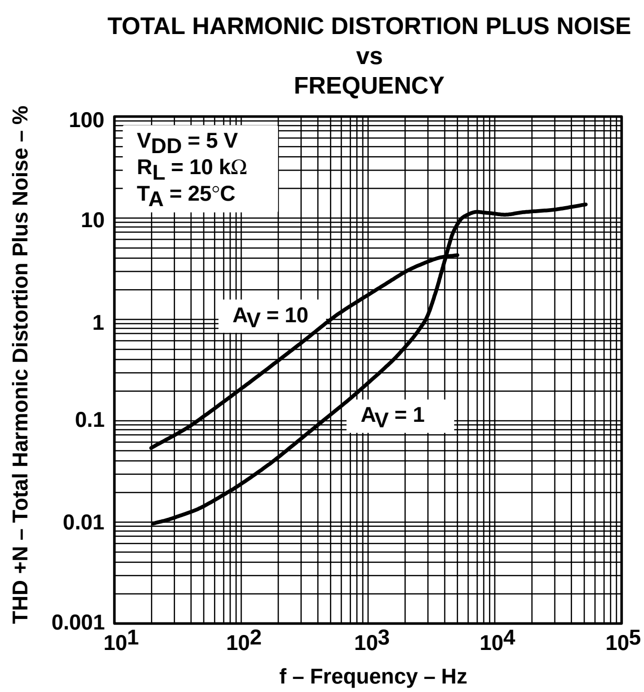

Figure 45

TYPICAL CHARACTERISTICS

GAIN-BANDWIDTH PRODUCT
vs
SUPPLY VOLTAGE

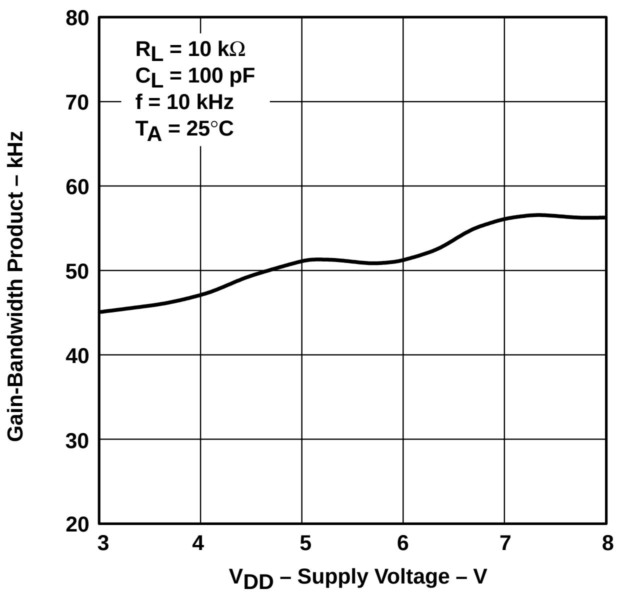

Figure 46

GAIN-BANDWIDTH PRODUCT
vs
FREE-AIR TEMPERATURE

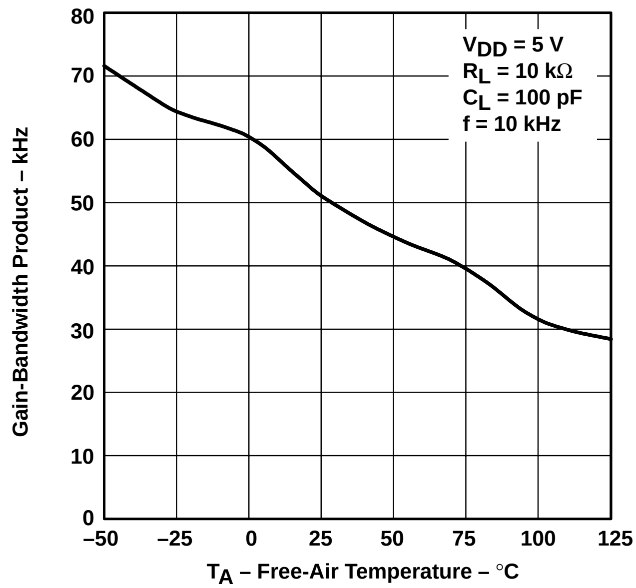

Figure 47

PHASE MARGIN
vs
LOAD CAPACITANCE

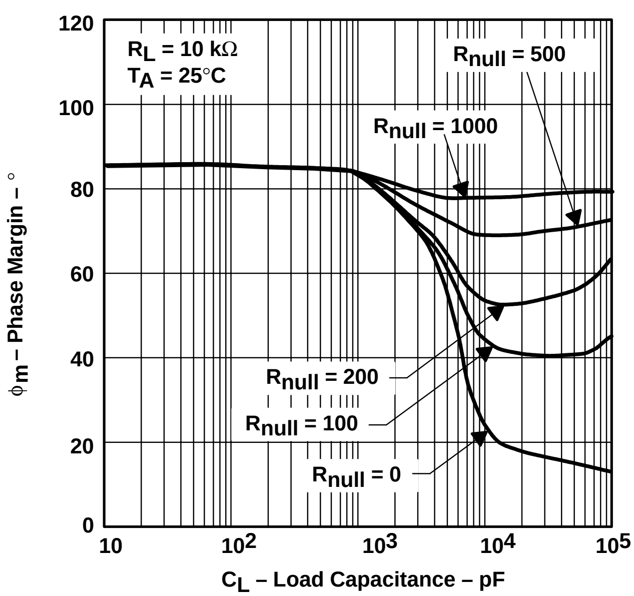

Figure 48

GAIN MARGIN
vs
LOAD CAPACITANCE

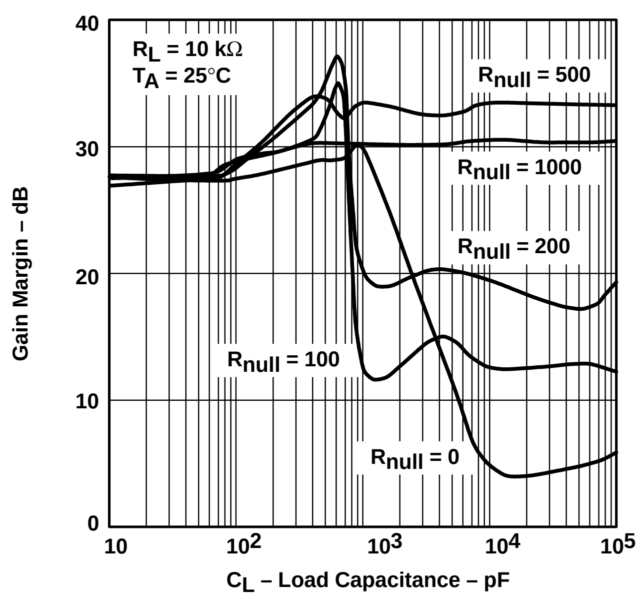

Figure 49

TYPICAL CHARACTERISTICS

UNITY-GAIN BANDWIDTH
vs
LOAD CAPACITANCE

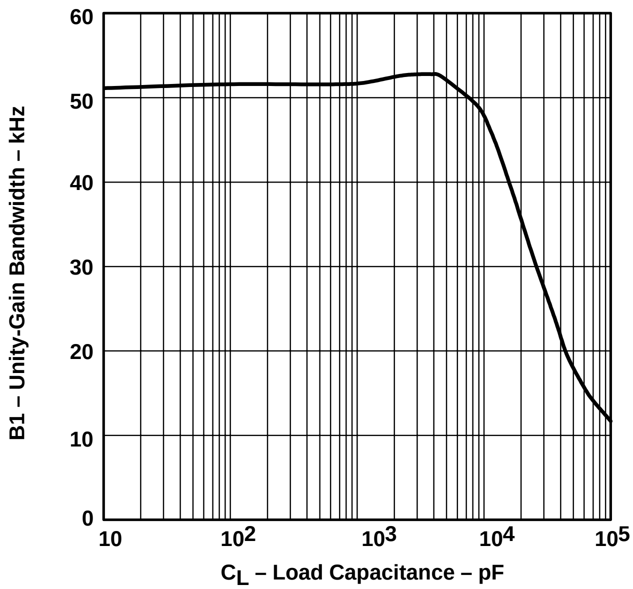

Figure 50

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9751401QHA	ACTIVE	CFP	U	10	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	9751401QHA TLV2422M	Samples
TLV2422AID	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	2422AI	Samples
TLV2422AIPWR	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	2422AI	Samples
TLV2422CD	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	2422C	Samples
TLV2422ID	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	2422I	Samples
TLV2422IDR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	2422I	Samples
TLV2422MUB	ACTIVE	CFP	U	10	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	9751401QHA TLV2422M	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF TLV2422, TLV2422M :

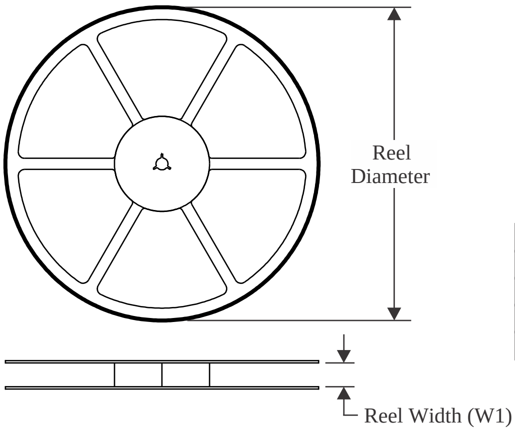
- Catalog : TLV2422
- Automotive : TLV2422-Q1, TLV2422-Q1
- Military : TLV2422M

NOTE: Qualified Version Definitions:

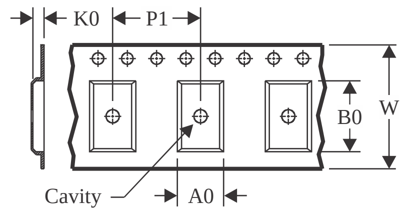
- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION

REEL DIMENSIONS

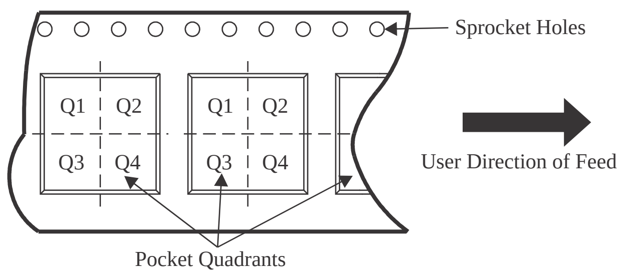


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

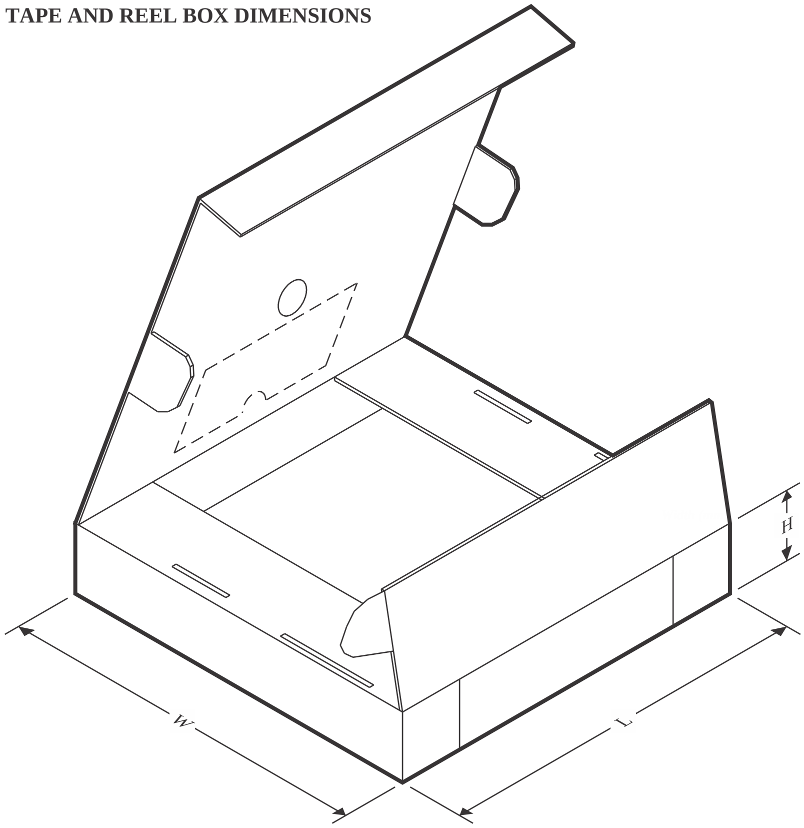
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLV2422AIPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
TLV2422IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

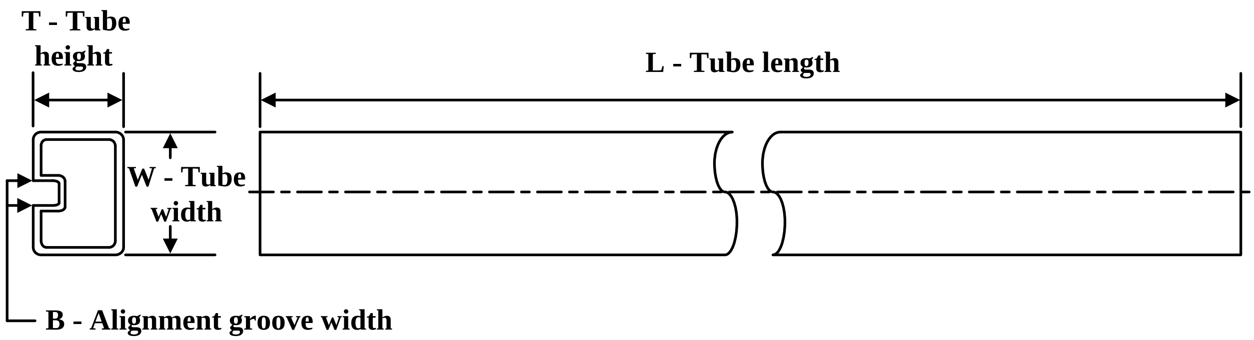
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

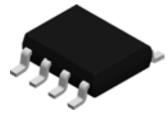
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLV2422AIPWR	TSSOP	PW	8	2000	356.0	356.0	35.0
TLV2422IDR	SOIC	D	8	2500	353.0	353.0	32.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-9751401QHA	U	CFP	10	25	506.98	26.16	6220	NA
TLV2422AID	D	SOIC	8	75	507	8	3940	4.32
TLV2422AID	D	SOIC	8	75	505.46	6.76	3810	4
TLV2422CD	D	SOIC	8	75	505.46	6.76	3810	4
TLV2422CD	D	SOIC	8	75	507	8	3940	4.32
TLV2422ID	D	SOIC	8	75	505.46	6.76	3810	4
TLV2422ID	D	SOIC	8	75	507	8	3940	4.32
TLV2422MUB	U	CFP	10	25	506.98	26.16	6220	NA

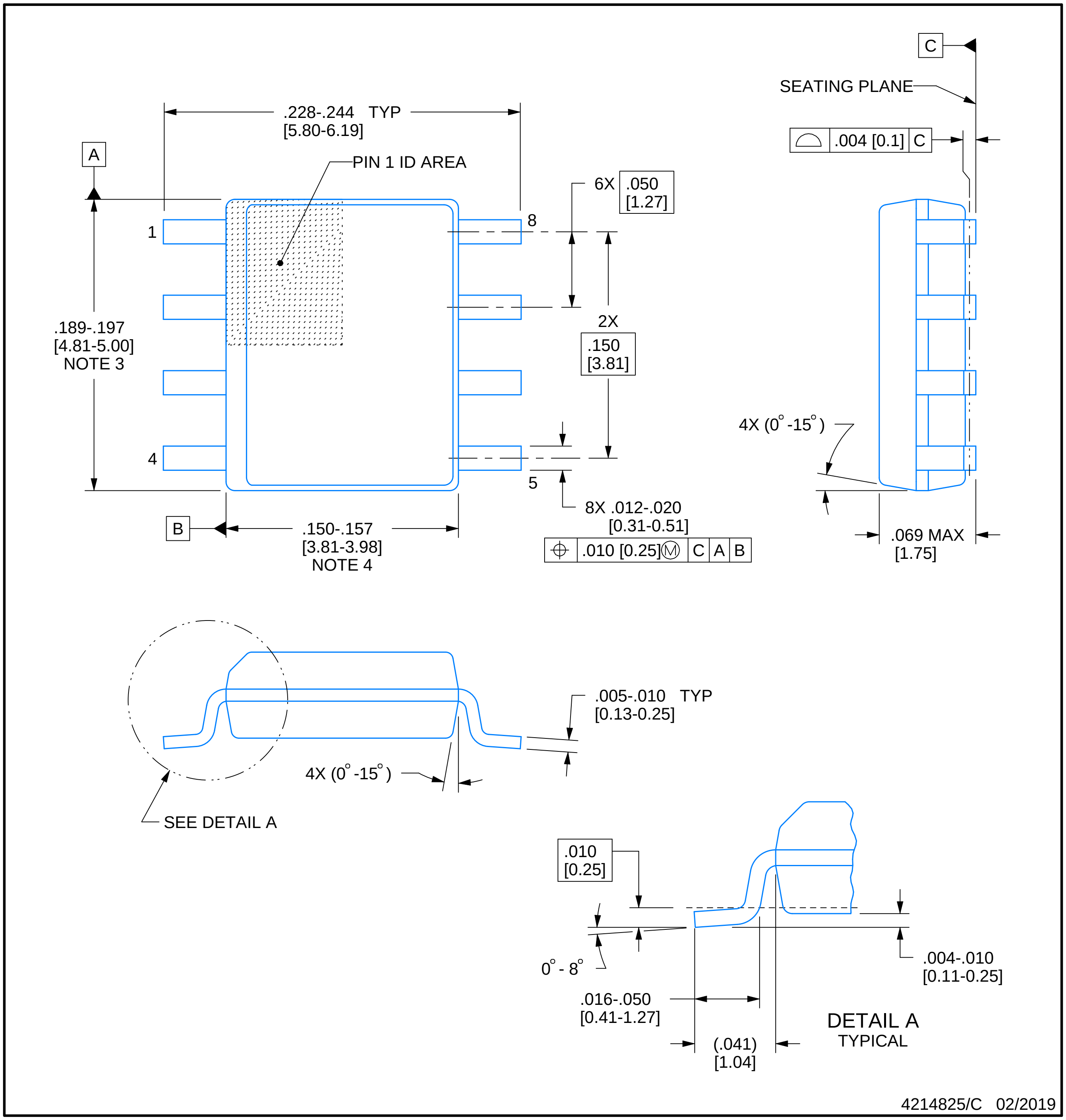


PACKAGE OUTLINE

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

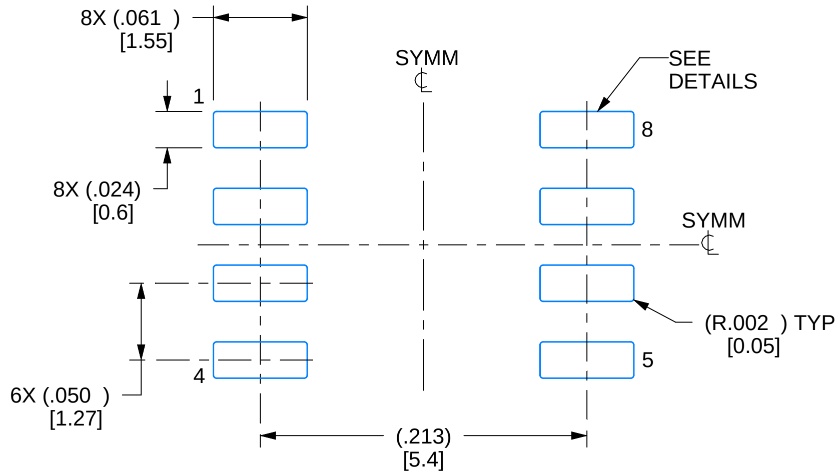
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

EXAMPLE BOARD LAYOUT

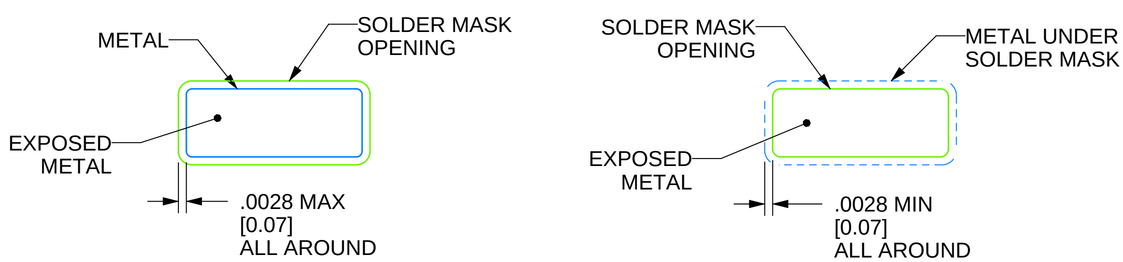
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



NON SOLDER MASK DEFINED

SOLDER MASK DEFINED

SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

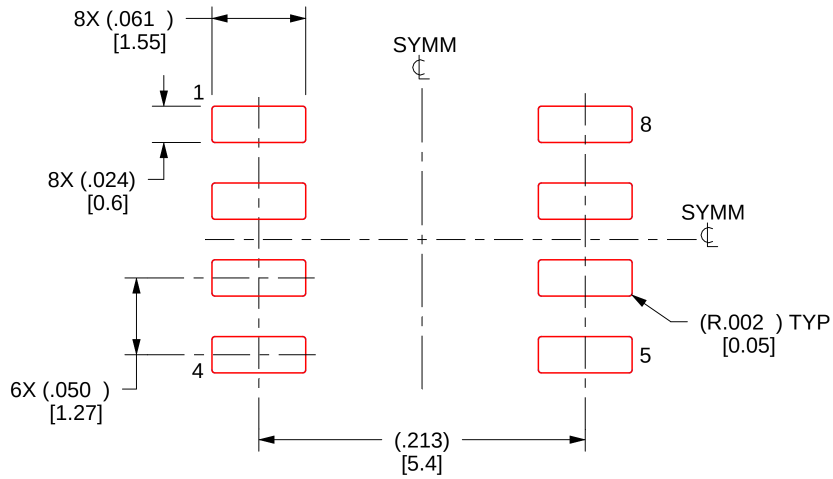
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

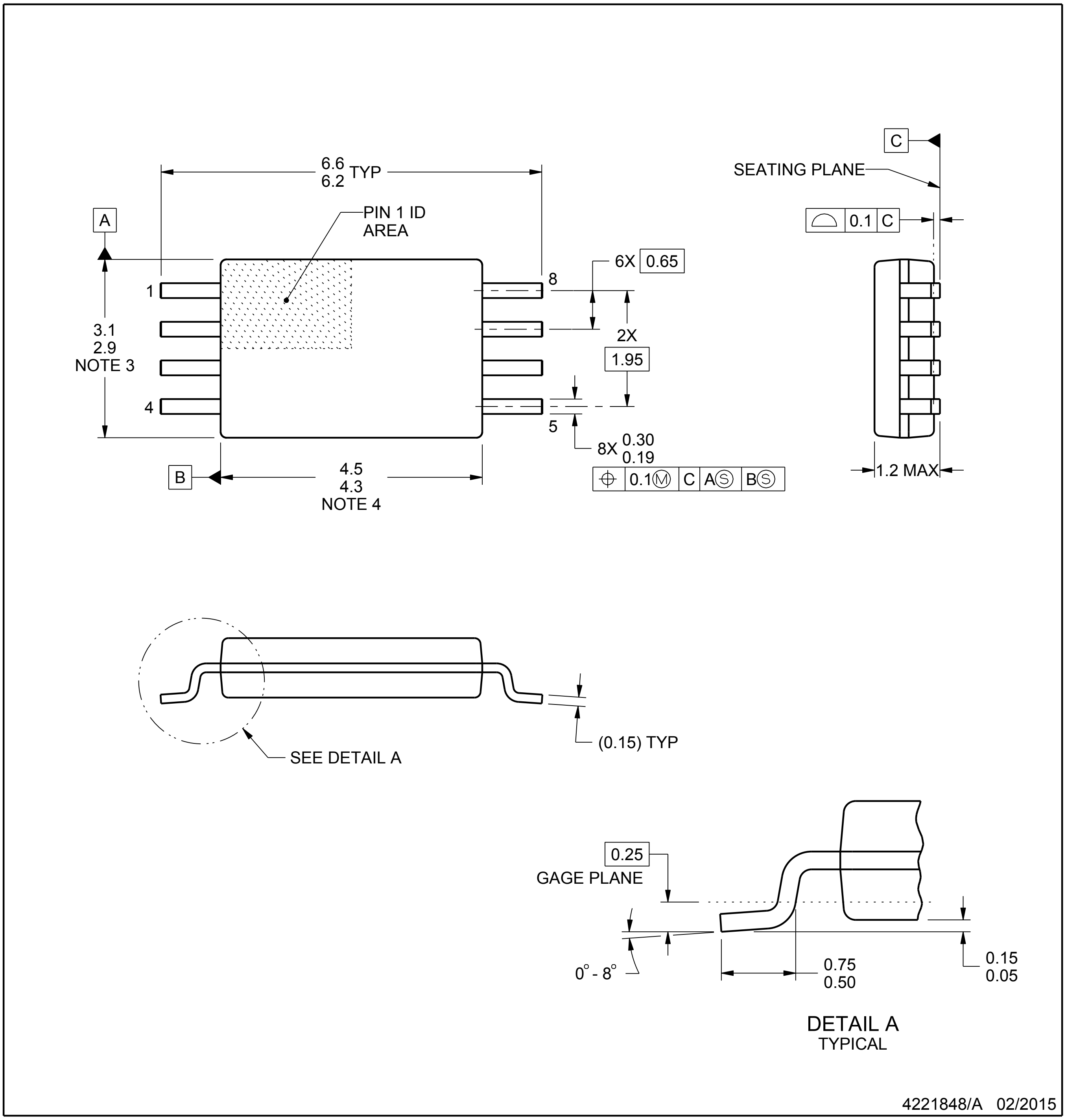
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

PACKAGE OUTLINE

PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

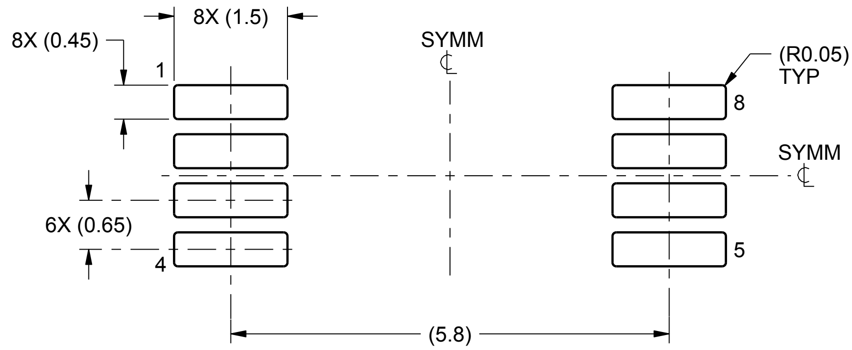
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153, variation AA.

EXAMPLE BOARD LAYOUT

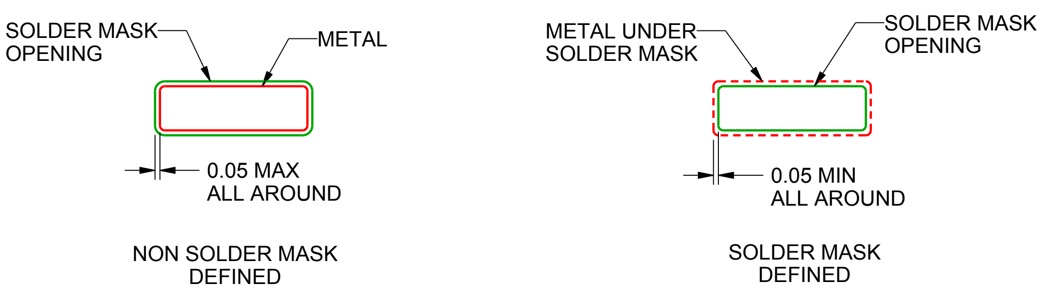
PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:10X



SOLDER MASK DETAILS
NOT TO SCALE

4221848/A 02/2015

NOTES: (continued)

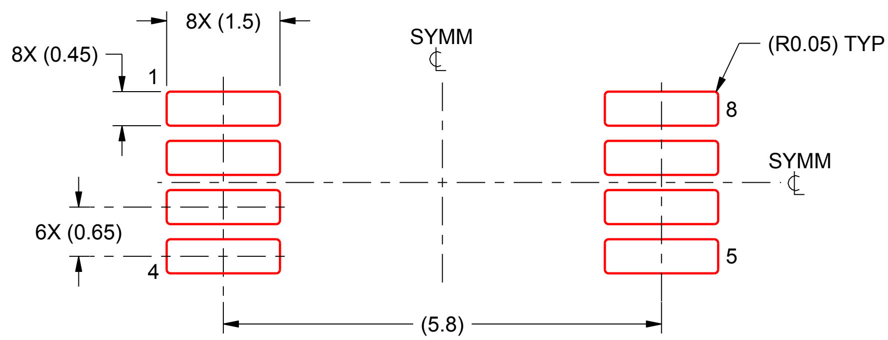
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:10X

4221848/A 02/2015

NOTES: (continued)

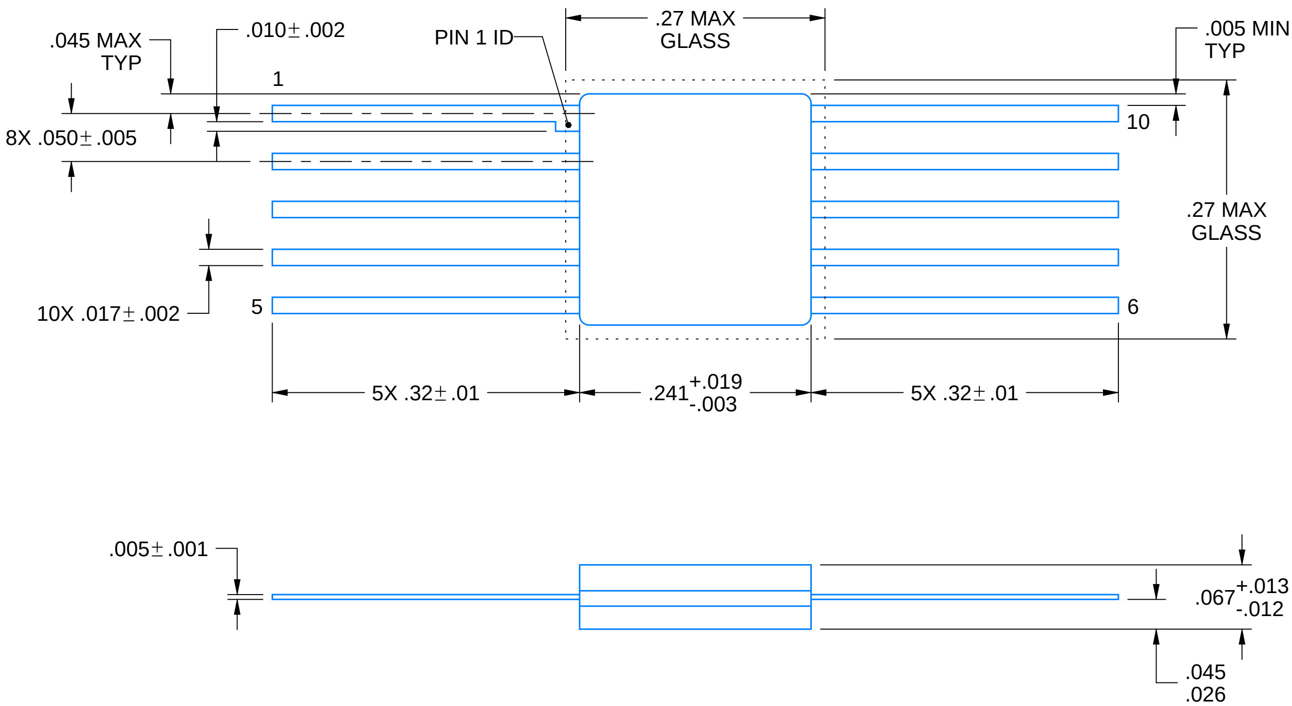
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

PACKAGE OUTLINE

U0010A

CFP - 2.03 mm max height

CERAMIC FLATPACK



NOTES:

1. All linear dimensions are in inches. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

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